



# VCA821 Ultra-Wideband, > 40-dB Gain Adjust Range, Linear in dB Variable Gain Amplifier

## 1 Features

- 710-MHz Small-Signal Bandwidth ( $G = +2$  V/V)
- 320 MHz, 4  $V_{PP}$  Bandwidth ( $G = +10$  V/V)
- 0.1-dB Gain Flatness to 135 MHz
- 2500 V/ $\mu$ s Slew Rate
- > 40-dB Gain Adjust Range
- High Gain Accuracy: 20 dB  $\pm 0.3$  dB
- High Output Current:  $\pm 90$  mA

## 2 Applications

- AGC Receivers With RSSI
- Differential Line Receivers
- Pulse Amplitude Compensation
- Variable Attenuators
- Voltage-Tunable Active Filters

## 3 Description

The VCA821 device is a DC-coupled, wideband, linear in dB, continuously variable, voltage-controlled gain amplifier. It provides a differential input to single-ended conversion with a high-impedance gain control input used to vary the gain down 40 dB from the nominal maximum gain set by the gain resistor ( $R_G$ ) and feedback resistor ( $R_F$ ).

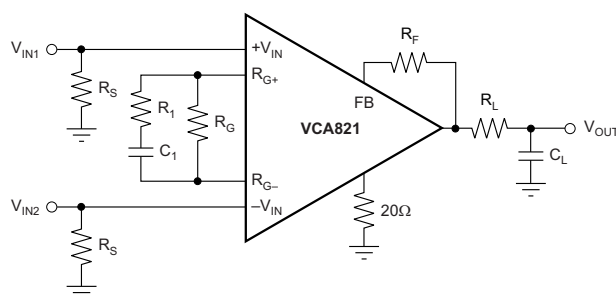
The VCA821 device internal architecture consists of two input buffers and an output current feedback amplifier stage integrated with a multiplier core to provide a complete variable gain amplifier (VGA) system that does not require external buffering. The maximum gain is set externally with two resistors, providing flexibility in designs. The maximum gain is intended to be set between 6 dB and 32 dB. Operating from  $\pm 5$ -V supplies, the gain control voltage for the VCA821 device adjusts the gain linearly in dB as the control voltage varies from 0V to +2 V. For example, set at a maximum gain of 20 dB, the VCA821 device provides 20 dB, at  $V_G = +2$  V, to less than -20 dB at  $V_G = 0$  V. The VCA821 device offers excellent gain linearity. For a 20-dB maximum gain, and a gain-control input voltage varying between +1 V and +2 V, the gain does not deviate by more than  $\pm 0.3$  dB (maximum at +25°C).

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)          |
|-------------|------------|--------------------------|
| VCA821      | SOIC (14)  | 8.65 mm $\times$ 3.91 mm |
|             | VSSOP (10) | 3.00 mm $\times$ 3.00 mm |

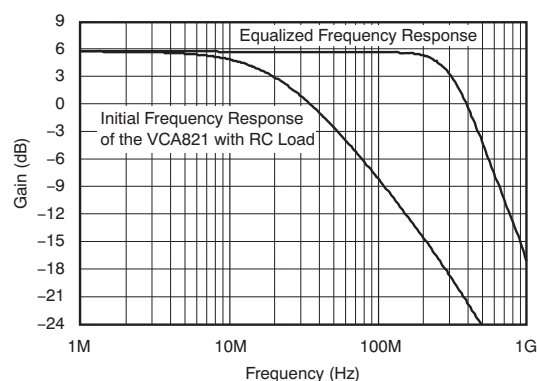
(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Differential Equalizer



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### Differential Equalization of an RC Load



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision C (October 2015) to Revision D | Page |
|------------------------------------------------------|------|
| • Changed Output voltage swing values .....          | 8    |
| • Changed Output current values .....                | 8    |

| Changes from Revision B (December 2008) to Revision C                                                                                                                                                                                                                                                                                                                                                                                               | Page |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Recommended Operating Conditions</i> table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section ..... | 1    |
| • Deleted <i>Ordering Information</i> table .....                                                                                                                                                                                                                                                                                                                                                                                                   | 1    |

| Changes from Revision A (August 2008) to Revision B                                                            | Page |
|----------------------------------------------------------------------------------------------------------------|------|
| • Revised second paragraph in <i>Wideband Variable Gain Amplifier Operation</i> section describing pin 9 ..... | 29   |

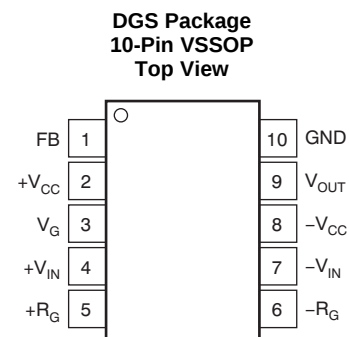
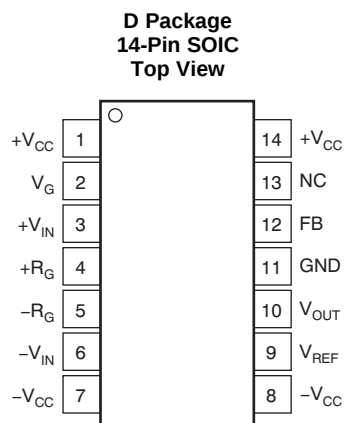
| Changes from Original (December 2007) to Revision A                                                                                                                                               | Page |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Changed storage temperature range rating in <i>Absolute Maximum Ratings</i> table from $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ to $-65^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ ..... | 5    |

## 5 Device Comparison Table

**VCA821 Related Products**

| SINGLES                | DUALS                   | GAIN ADJUST RANGE<br>(dB) | INPUT NOISE<br>(nV/ $\sqrt{\text{Hz}}$ ) | SIGNAL BANDWIDTH (MHz) |
|------------------------|-------------------------|---------------------------|------------------------------------------|------------------------|
| <a href="#">VCA810</a> | —                       | 80                        | 2.4                                      | 35                     |
| —                      | <a href="#">VCA2612</a> | 45                        | 1.25                                     | 80                     |
| —                      | <a href="#">VCA2613</a> | 45                        | 1                                        | 80                     |
| —                      | <a href="#">VCA2615</a> | 52                        | 0.8                                      | 50                     |
| —                      | <a href="#">VCA2617</a> | 48                        | 4.1                                      | 50                     |
| <a href="#">VCA820</a> | —                       | 40                        | 8.2                                      | 150                    |
| <a href="#">VCA821</a> | —                       | 40                        | 6.0                                      | 420                    |
| <a href="#">VCA822</a> | —                       | 40                        | 8.2                                      | 150                    |
| <a href="#">VCA824</a> | —                       | 40                        | 6.0                                      | 420                    |

## 6 Pin Configuration and Functions



NC = No Connection

### Pin Functions

| PIN  |       |       | I/O | DESCRIPTION              |
|------|-------|-------|-----|--------------------------|
| NAME | SOIC  | VSSOP |     |                          |
| FB   | 12    | 1     | I   | Feedback Resistor Input  |
| GND  | 11    | 10    | —   | Ground                   |
| NC   | 13    | —     | —   | No Connection            |
| +RG  | 4     | 5     | I   | Gain Set Resistor        |
| -RG  | 5     | 6     | I   | Gain Set Resistor        |
| +VCC | 1, 14 | 2     | P   | Positive Supply          |
| -VCC | 7, 8  | 8     | P   | Negative Supply          |
| +VIN | 3     | 4     | I   | Gain Control             |
| -VIN | 6     | 7     | I   | Inverting Input          |
| VG   | 2     | 3     | I   | Noninverting Input       |
| VOUT | 10    | 9     | O   | Output                   |
| VREF | 9     | —     | I   | Output Voltage Reference |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                                     | MIN                                     | MAX             | UNIT |
|---------------------------------------------------------------------|-----------------------------------------|-----------------|------|
| Power Supply                                                        |                                         | ±6.5            | V    |
| Internal Power Dissipation                                          | See <a href="#">Thermal Information</a> |                 |      |
| Input Voltage                                                       |                                         | ±V <sub>S</sub> | V    |
| Lead Temperature (soldering, 10 s)                                  |                                         | 260             | °C   |
| Junction Temperature (T <sub>J</sub> )                              |                                         | 150             | °C   |
| Junction Temperature (T <sub>J</sub> ) Maximum Continuous Operation |                                         | 140             | °C   |
| Storage Temperature (T <sub>stg</sub> )                             | –65                                     | 125             | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |
|                                            | Machine Model                                                                  | ±200  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                       | MIN | NOM | MAX | UNIT |
|-----------------------|-----|-----|-----|------|
| Operating voltage     | 7   | 10  | 12  | V    |
| Operating temperature | –40 | 25  | 85  | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | VCA821   |             | UNIT |
|-------------------------------|----------------------------------------------|----------|-------------|------|
|                               |                                              | D [SOIC] | DGS [VSSOP] |      |
|                               |                                              | 14 PINS  | 10 PINS     |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 90.3     | 173.1       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 49.8     | 46.6        | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 44.9     | 94.3        | °C/W |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 13.8     | 2.2         | °C/W |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 44.6     | 92.7        | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | n/a      | n/a         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

# VCA821

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## 7.5 Electrical Characteristics: $V_S = \pm 5\text{ V}$

At  $A_{V_{MAX}} = 20\text{ dB}$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $R_L = 100\ \Omega$ , unless otherwise noted.

| PARAMETER                               | TEST CONDITIONS                                                                                                                                | MIN                             | TYP        | MAX        | UNIT                           | TEST LEVEL <sup>(1)</sup> |
|-----------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------|------------|------------|--------------------------------|---------------------------|
| <b>AC PERFORMANCE</b>                   |                                                                                                                                                |                                 |            |            |                                |                           |
| Small-signal bandwidth                  | $G = 6\text{ dB}$ , $V_O = 500\text{ mV}_{PP}$ $G = 20\text{ dB}$ , $V_O = 500\text{ mV}_{PP}$ $G = 40\text{ dB}$ , $V_O = 500\text{ mV}_{PP}$ |                                 | 710        |            | MHz                            | C                         |
|                                         |                                                                                                                                                |                                 | 420        |            | MHz                            | C                         |
|                                         |                                                                                                                                                |                                 | 170        |            | MHz                            | C                         |
| Large-signal bandwidth                  | $G = 20\text{ dB}$ , $V_O = 4\text{ V}_{PP}$                                                                                                   |                                 | 320        |            | MHz                            | C                         |
| Gain control bandwidth                  | $V_O = 200\text{ mV}_{PP}$                                                                                                                     | +25° C <sup>(2)</sup>           | 240        | 330        | MHz                            | B                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    | 235        |            |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> | 235        |            |                                |                           |
| Bandwidth for 0.1dB flatness            | $G = 20\text{ dB}$ , $V_O = 200\text{ mV}_{PP}$                                                                                                |                                 | 135        |            | MHz                            | C                         |
| Slew rate                               | $G = 20\text{ dB}$ , $V_O = 5\text{ V Step}$                                                                                                   | +25° C <sup>(2)</sup>           | 1800       | 2500       | V/ $\mu$ s                     | B                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    | 1700       |            |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> | 1700       |            |                                |                           |
| Rise-and-fall time                      | $G = 20\text{ dB}$ , $V_O = 5\text{ V Step}$                                                                                                   | +25° C <sup>(2)</sup>           | 1.5        | 1.8        | ns                             | B                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | 1.9        |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | 1.9        |                                |                           |
| Settling time to 0.01%                  | $G = 20\text{ dB}$ , $V_O = 5\text{ V Step}$                                                                                                   |                                 | 11         |            | ns                             | C                         |
| Harmonic distortion, 2nd-harmonic       | $V_O = 2\text{ V}_{PP}$ , $f = 20\text{ MHz}$                                                                                                  | +25° C <sup>(2)</sup>           | –64        | –66        | dBc                            | B                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    | –64        |            |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> | –64        |            |                                |                           |
| Harmonic distortion, 3rd -harmonic      | $V_O = 2\text{ V}_{PP}$ , $f = 20\text{ MHz}$                                                                                                  | +25° C <sup>(2)</sup>           | –61        | –63        | dBc                            | B                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    | –61        |            |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> | –61        |            |                                |                           |
| Input voltage noise                     | $f > 100\text{ kHz}$                                                                                                                           |                                 | 6.0        |            | nV/ $\sqrt{\text{Hz}}$         | C                         |
| Input current noise                     | $f > 100\text{ kHz}$                                                                                                                           |                                 | 2.6        |            | pA/ $\sqrt{\text{Hz}}$         | C                         |
| <b>GAIN CONTROL</b>                     |                                                                                                                                                |                                 |            |            |                                |                           |
| Absolute gain error                     | $G_{MAX} = 20\text{ dB}$ , $V_G = 2\text{ V}$                                                                                                  | +25° C <sup>(2)</sup>           | $\pm 0.1$  | $\pm 0.4$  | dB                             | A                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | $\pm 0.5$  |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | $\pm 0.6$  |                                |                           |
| $V_{ctrl0}$                             |                                                                                                                                                |                                 | 0.85       |            | V                              | C                         |
| $V_{slope}$                             |                                                                                                                                                |                                 | 0.09       |            | V                              | C                         |
| Absolute gain error                     | $G_{MAX} = 20\text{ dB}$ , $V_G = 1\text{ V}$ ,<br>( $G = 18.06\text{ dB}$ )                                                                   | +25° C <sup>(2)</sup>           | $\pm 0.3$  | $\pm 0.4$  | dB                             | A                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | $\pm 0.5$  |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | $\pm 0.6$  |                                |                           |
| Gain at $V_G = 0.2\text{ V}$            | Relative to max gain                                                                                                                           | +25° C <sup>(2)</sup>           | –26        | –24        | dB                             | A                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | –24        |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | –23        |                                |                           |
| Gain control bias current               |                                                                                                                                                | +25° C <sup>(2)</sup>           | 10         | 16         | $\mu$ A                        | A                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | 16.6       |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | 16.7       |                                |                           |
| Average gain control bias current drift |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | $\pm 12$   | nA/ $^{\circ}\text{C}$         | B                         |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | $\pm 12$   |                                |                           |
| Gain control input impedance            |                                                                                                                                                |                                 | 1.5    0.6 |            | M $\Omega$    pF               | C                         |
| <b>DC PERFORMANCE</b>                   |                                                                                                                                                |                                 |            |            |                                |                           |
| Input offset voltage                    | $G = 20\text{ dB}$ , $V_{CM} = 0\text{ V}$ , $V_G = 1\text{ V}$                                                                                | +25° C <sup>(2)</sup>           | $\pm 4$    | $\pm 17$   | mV                             | A                         |
|                                         |                                                                                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | $\pm 17.8$ |                                |                           |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | $\pm 19$   |                                |                           |
| Average input offset voltage drift      | $G = 20\text{ dB}$ , $V_{CM} = 0\text{ V}$ , $V_G = 1\text{ V}$                                                                                | 0° C to 70° C <sup>(3)</sup>    |            | 30         | $\mu\text{V}/^{\circ}\text{C}$ | B                         |
|                                         |                                                                                                                                                | –40° C to +85° C <sup>(3)</sup> |            | 30         |                                |                           |

- (1) Test levels: (A) 100% tested at +25°C. Over temperature limits set by characterization and simulation. (B) Limits set by characterization and simulation. (C) Typical value only for information.
- (2) Junction temperature = ambient for +25°C tested specifications.
- (3) Junction temperature = ambient at low temperature limit; junction temperature = ambient +23°C at high temperature limit for over temperature specifications.

## Electrical Characteristics: $V_S = \pm 5\text{ V}$ (continued)

At  $A_{V_{MAX}} = 20\text{ dB}$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $R_L = 100\ \Omega$ , unless otherwise noted.

| PARAMETER                                               | TEST CONDITIONS                                     |                                 | MIN  | TYP        | MAX   | UNIT     | TEST LEVEL <sup>(1)</sup> |
|---------------------------------------------------------|-----------------------------------------------------|---------------------------------|------|------------|-------|----------|---------------------------|
| Input bias current                                      | G = 20dB, V <sub>CM</sub> = 0V, V <sub>G</sub> = 1V | +25° C <sup>(2)</sup>           |      | 19         | 25    | μA       | A                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    |      |            | 29    |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> |      |            | 31    |          |                           |
| Average input bias current drift                        | G = 20dB, V <sub>CM</sub> = 0V, V <sub>G</sub> = 1V | 0° C to 70° C <sup>(3)</sup>    |      |            | 90    | nA/°C    | B                         |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> |      |            | 90    |          |                           |
| Input offset current                                    | G = 20dB, V <sub>CM</sub> = 0V, V <sub>G</sub> = 1V | +25° C <sup>(2)</sup>           |      | ±0.5       | ±2.5  | μA       | A                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    |      |            | ±3.2  |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> |      |            | ±3.5  |          |                           |
| Average input offset current drift                      | G = 20dB, V <sub>CM</sub> = 0V, V <sub>G</sub> = 1V | 0° C to 70° C <sup>(3)</sup>    |      |            | ±16   | nA/°C    | B                         |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> |      |            | ±16   |          |                           |
| I <sub>RG MAX</sub> Max current through gain resistance |                                                     | +25° C <sup>(2)</sup>           |      | ±2.6       | ±2.55 | mA       | B                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    |      |            | ±2.55 |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> |      |            | ±2.5  |          |                           |
| INPUT                                                   |                                                     |                                 |      |            |       |          |                           |
| Most positive common mode input voltage                 | R <sub>L</sub> = 100Ω                               | +25° C <sup>(2)</sup>           | +1.6 | +1.6       |       | V        | A                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    | +1.6 |            |       |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> | +1.6 |            |       |          |                           |
| Most negative common mode input voltage                 | R <sub>L</sub> = 100Ω                               | +25° C <sup>(2)</sup>           | −2.1 | −2.1       |       | V        | A                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    | −2.1 |            |       |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> | −2.1 |            |       |          |                           |
| Common-mode rejection ratio                             | V <sub>CM</sub> = ±0.5V                             | +25° C <sup>(2)</sup>           | 65   | 80         |       | dB       | A                         |
|                                                         |                                                     | 0° C to 70° C <sup>(3)</sup>    | 60   |            |       |          |                           |
|                                                         |                                                     | −40° C to +85° C <sup>(3)</sup> | 60   |            |       |          |                           |
| Input impedance, differential                           |                                                     |                                 |      | 0.9    0.6 |       | MΩ    pF | C                         |
| Input impedance, common-mode                            |                                                     |                                 |      | 1    2     |       | MΩ    pF | C                         |

**VCA821**

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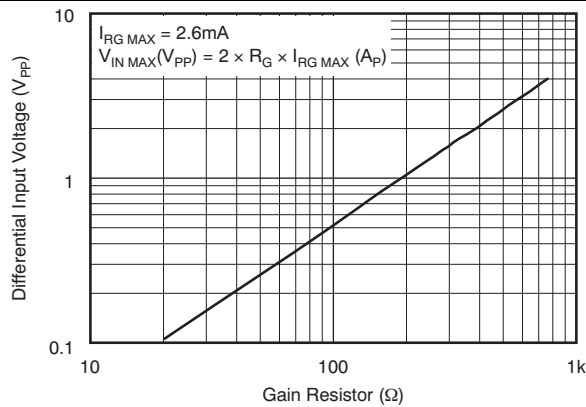
[www.ti.com](http://www.ti.com)
**Electrical Characteristics:  $V_S = \pm 5\text{ V}$  (continued)**

At  $A_{V_{MAX}} = 20\text{ dB}$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $R_L = 100\ \Omega$ , unless otherwise noted.

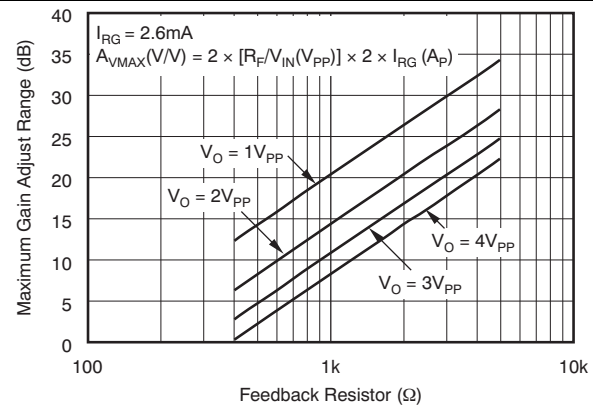
| PARAMETER                                              |                                           | TEST CONDITIONS                 |      | MIN       | TYP        | MAX  | UNIT | TEST LEVEL <sup>(1)</sup> |
|--------------------------------------------------------|-------------------------------------------|---------------------------------|------|-----------|------------|------|------|---------------------------|
| OUTPUT                                                 |                                           |                                 |      |           |            |      |      |                           |
| Output voltage swing                                   | R <sub>L</sub> = 1kΩ                      | +25° C <sup>(2)</sup>           | ±3.6 | ±3.9      | V          | A    |      |                           |
|                                                        |                                           | 0° C to 70° C <sup>(3)</sup>    | ±3.4 |           |            |      |      |                           |
|                                                        |                                           | −40° C to +85° C <sup>(3)</sup> | ±3.3 |           |            |      |      |                           |
|                                                        | R <sub>L</sub> = 100Ω                     | +25° C <sup>(2)</sup>           | ±3.5 | −3.3/+3.6 | −3.2       | V    | A    |                           |
|                                                        |                                           | 0° C to 70° C <sup>(3)</sup>    | +3.3 |           | −3.0       |      |      |                           |
|                                                        |                                           | −40° C to +85° C <sup>(3)</sup> | +3.2 |           | −2.9       |      |      |                           |
| Output current                                         | V <sub>O</sub> = 0V, R <sub>L</sub> = 10Ω | +25° C <sup>(2)</sup>           | +60  | −55/+90   | −50        | mA   | A    |                           |
|                                                        |                                           | 0° C to 70° C <sup>(3)</sup>    | +50  |           | −42        |      |      |                           |
|                                                        |                                           | −40° C to +85° C <sup>(3)</sup> | +45  |           | −38        |      |      |                           |
| Output impedance                                       | G = +10V/V, f > 100kHz                    |                                 | 0.01 |           |            | Ω    | C    |                           |
| POWER SUPPLY                                           |                                           |                                 |      |           |            |      |      |                           |
| Specified operating voltage                            |                                           |                                 |      | ±5        |            |      | V    | C                         |
| Minimum operating voltage                              |                                           |                                 |      | ±3.5      |            |      | V    | C                         |
| Maximum operating voltage                              | +25° C <sup>(2)</sup>                     |                                 |      |           |            | ±6   | V    | A                         |
|                                                        | 0° C to 70° C <sup>(3)</sup>              |                                 |      |           |            | ±6   |      |                           |
|                                                        | −40° C to +85° C <sup>(3)</sup>           |                                 |      |           |            | ±6   |      |                           |
| Maximum quiescent current                              | V <sub>G</sub> = 1V                       | +25° C <sup>(2)</sup>           | 34   |           |            | 35   | mA   | A                         |
|                                                        |                                           | 0° C to 70° C <sup>(3)</sup>    |      |           |            | 35.5 |      |                           |
|                                                        |                                           | −40° C to +85° C <sup>(3)</sup> |      |           |            | 36   |      |                           |
| Minimum quiescent current                              | V <sub>G</sub> = 1V                       | +25° C <sup>(2)</sup>           | 34   |           |            | 32.5 | mA   | A                         |
|                                                        |                                           | 0° C to 70° C <sup>(3)</sup>    |      |           |            | 32   |      |                           |
|                                                        |                                           | −40° C to +85° C <sup>(3)</sup> |      |           |            | 31.5 |      |                           |
| −PSR<br>R      Power-supply rejection ratio            | +25° C <sup>(2)</sup>                     |                                 | −61  |           |            | −68  | dB   | A                         |
|                                                        | 0° C to 70° C <sup>(3)</sup>              |                                 | −59  |           |            |      |      |                           |
|                                                        | −40° C to +85° C <sup>(3)</sup>           |                                 | −58  |           |            |      |      |                           |
| THERMAL CHARACTERISTICS                                |                                           |                                 |      |           |            |      |      |                           |
| Specified operating range, D package                   |                                           |                                 |      |           | −40 to +85 |      | °C   | C                         |
| θ <sub>JA</sub> Junction-to-ambient thermal resistance | VSSOP-10 (DGS)                            |                                 |      |           | 130        |      | °C/W | C                         |
|                                                        | SOIC-14 (D)                               |                                 |      |           | 80         |      | °C/W | C                         |

## 7.6 Typical Characteristics: $V_S = \pm 5\text{ V}$ , DC Parameters

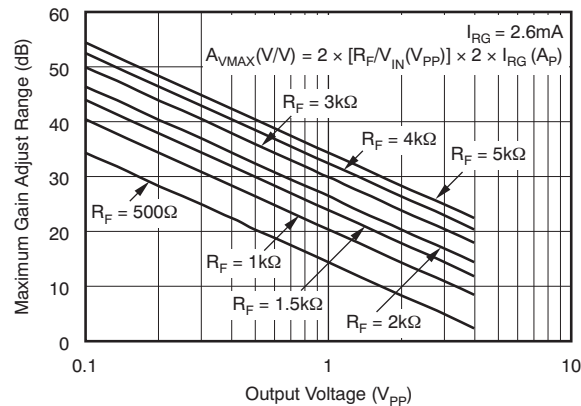
At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{IN}$  is single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, unless otherwise noted.



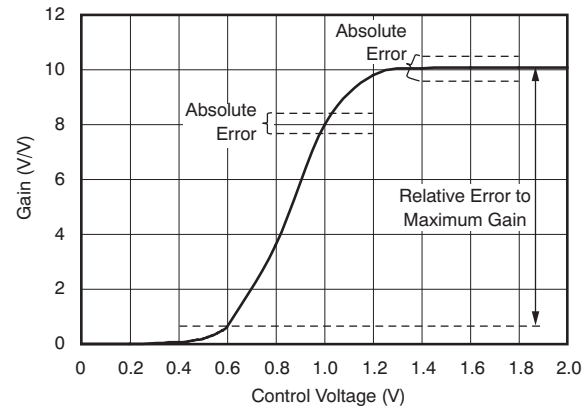
**Figure 1. Maximum Differential Input Voltage vs  $R_G$**



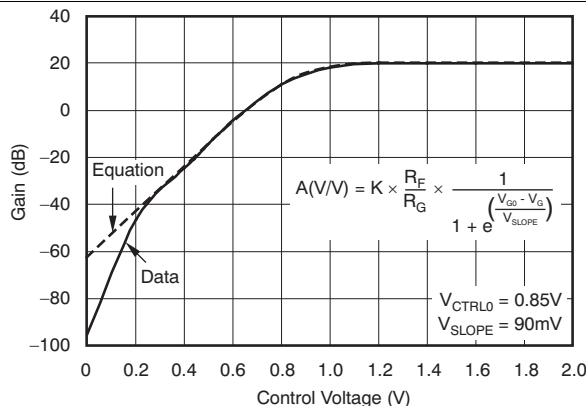
**Figure 2. Maximum Gain Adjust Range vs  $R_F$**



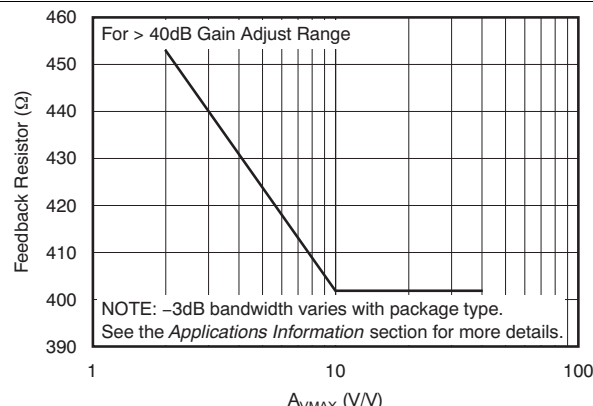
**Figure 3. Maximum Gain Adjust Range vs Peak-to-Peak Output Voltage**



**Figure 4. Gain Error Band vs Gain Control Voltage**



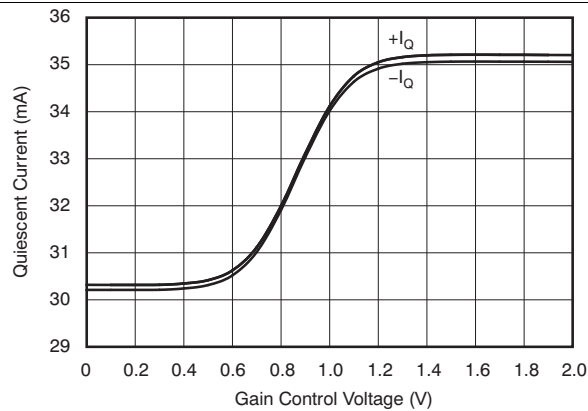
**Figure 5. Gain Error Band vs Gain Control Voltage**



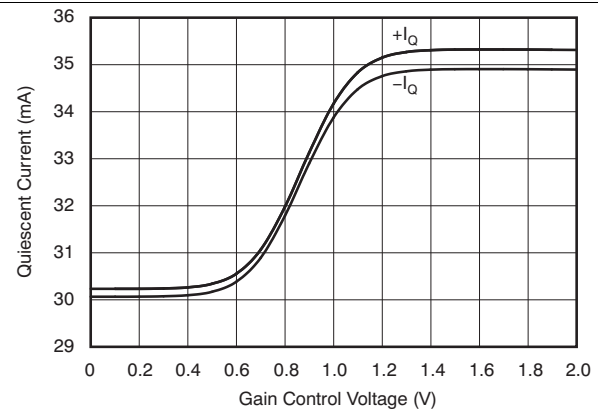
**Figure 6. Recommended  $R_F$  vs  $A_{VMAX}$**

## 7.7 Typical Characteristics: $V_S = \pm 5\text{ V}$ , DC and Power-Supply Parameters

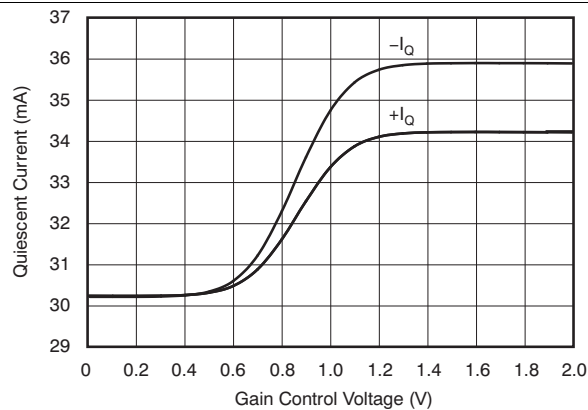
At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, unless otherwise noted.



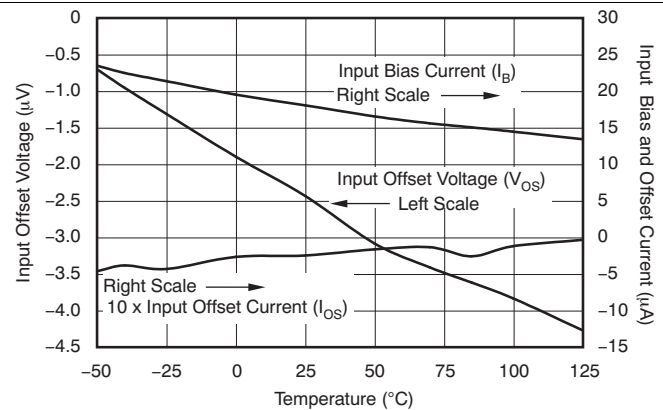
**Figure 7. Supply Current vs Control Voltage**  
( $A_{VMAX} = 6\text{ dB}$ )



**Figure 8. Supply Current vs Control voltage**  
( $A_{VMAX} = 20\text{ dB}$ )



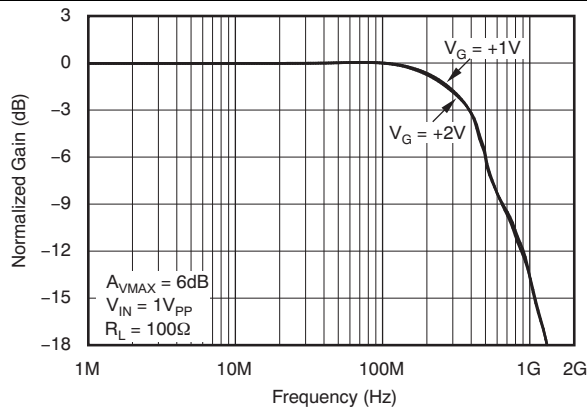
**Figure 9. Supply Current vs Control Voltage**  
( $A_{VMAX} = 32\text{ dB}$ )



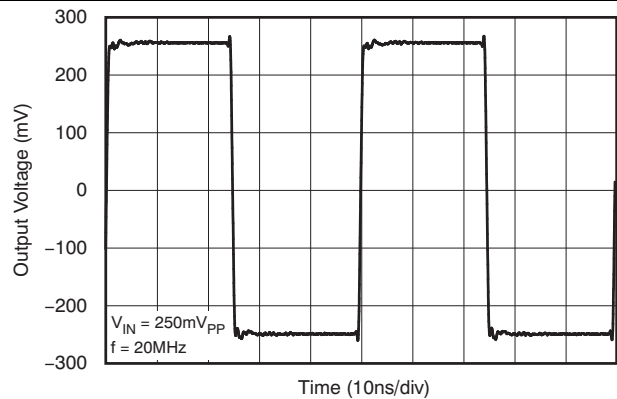
**Figure 10. Typical DC Drift vs Temperature**

## 7.8 Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{VMAX} = 6\text{ dB}$

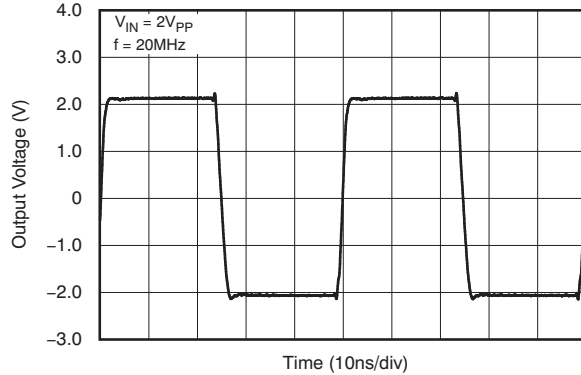
At  $T_A = 25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 453\ \Omega$ ,  $R_G = 453\ \Omega$ ,  $V_G = 2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.



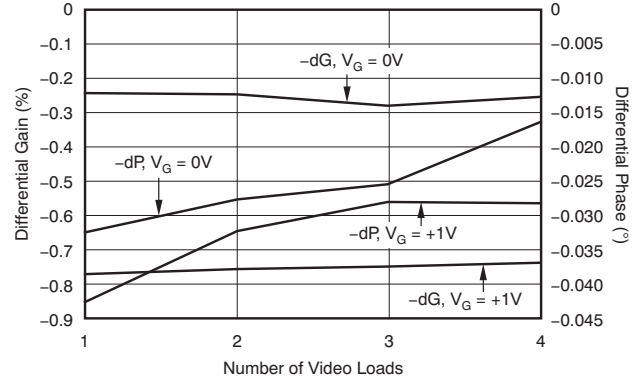
**Figure 11. Small-Signal Frequency Response**



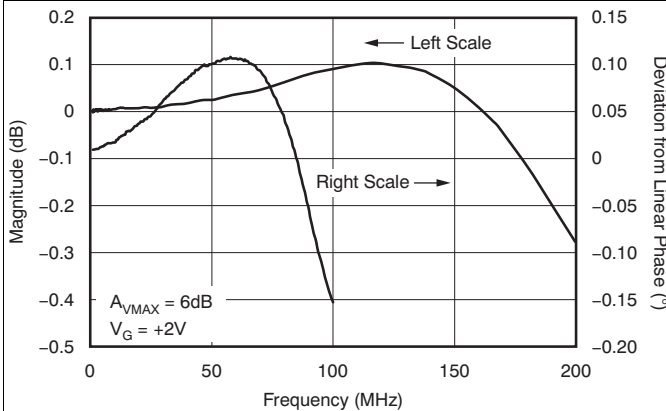
**Figure 12. Small-Signal Pulse Response**



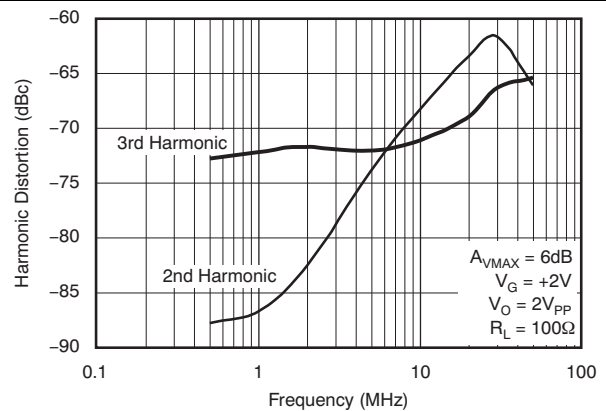
**Figure 13. Large-Signal Pulse Response**



**Figure 14. Composite Video dG/dP**



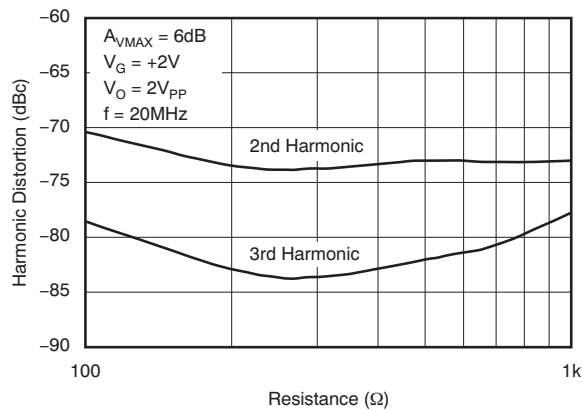
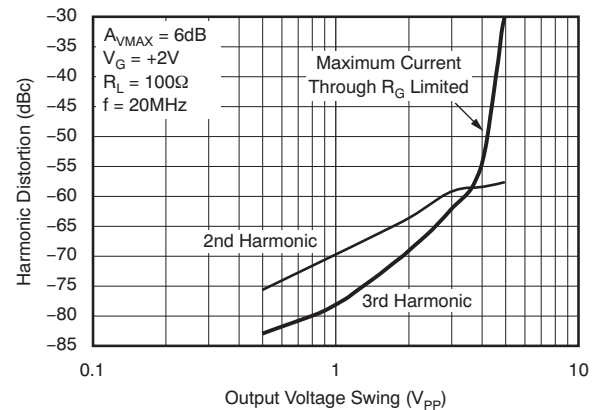
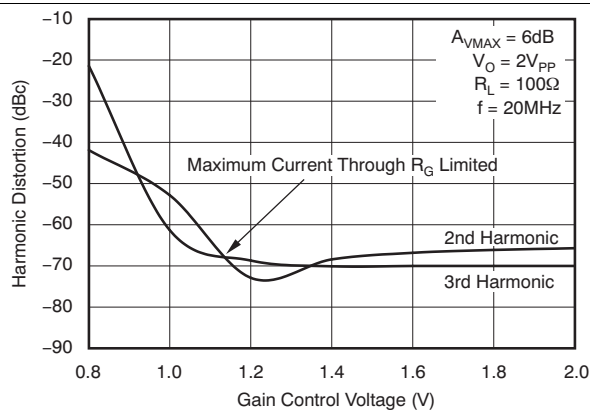
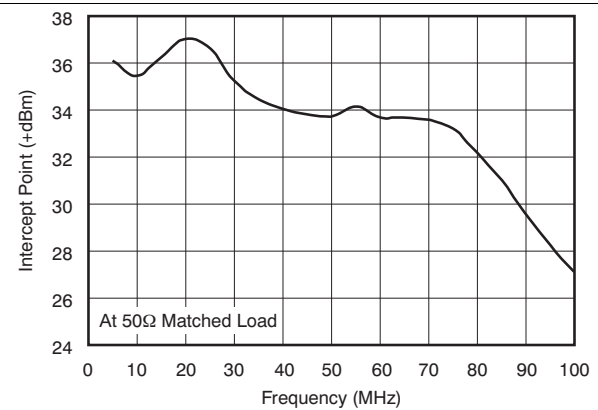
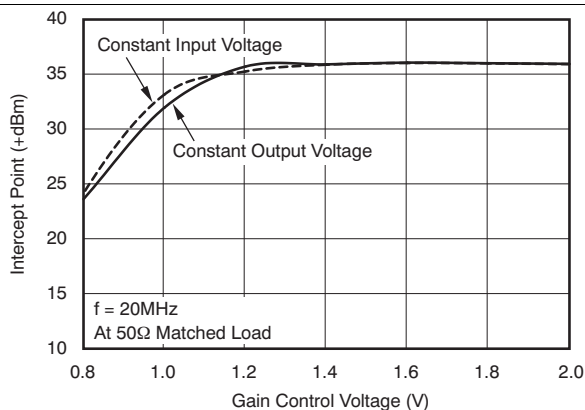
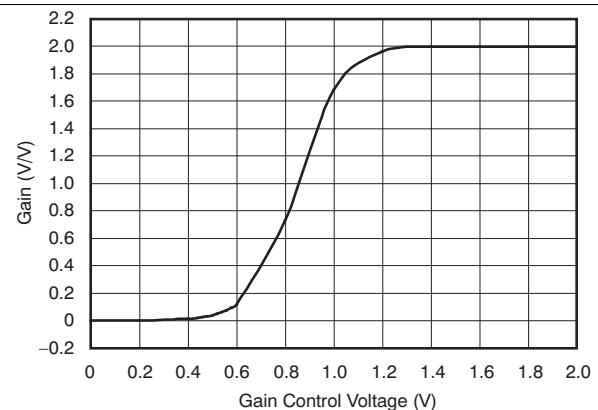
**Figure 15. Gain Flatness, Deviation From Linear Phase**



**Figure 16. Harmonic Distortion vs Frequency**

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{VMAX} = 6\text{ dB}$ (continued)

At  $T_A = 25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 453\ \Omega$ ,  $R_G = 453\ \Omega$ ,  $V_G = 2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.


**Figure 17. Harmonic Distortion vs Load Resistance**

**Figure 18. Harmonic Distortion vs Output Voltage**

**Figure 19. Harmonic Distortion vs Gain Control Voltage**

**Figure 20. Two-Tone, Third-Order Intermodulation Intercept**

**Figure 21. Two-Tone, Third-Order Intermodulation Intercept vs Gain Control Voltage**

**Figure 22. Gain vs Gain Control Voltage**

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V_{MAX}} = 6\text{ dB}$ (continued)

At  $T_A = 25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 453\ \Omega$ ,  $R_G = 453\ \Omega$ ,  $V_G = 2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.

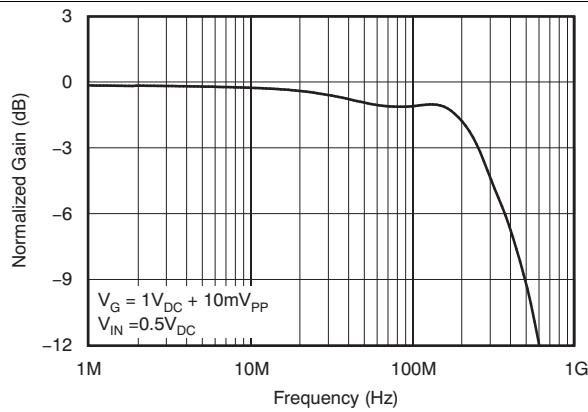


Figure 23. Gain Control Frequency Response

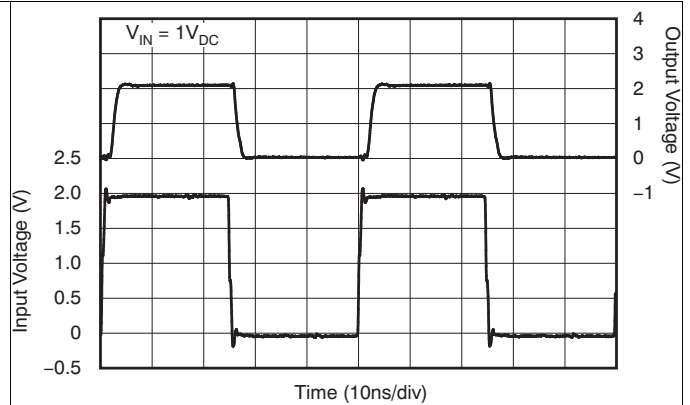


Figure 24. Gain Control Pulse Response

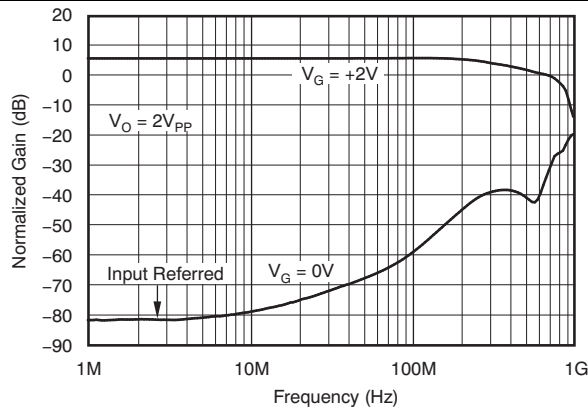


Figure 25. Fully-Attenuated Response

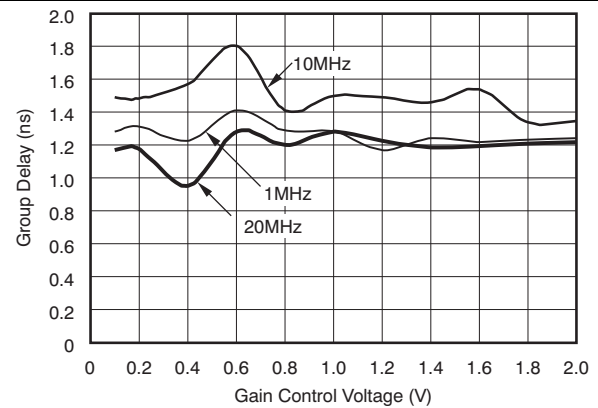


Figure 26. Group Delay vs Gain Control Voltage

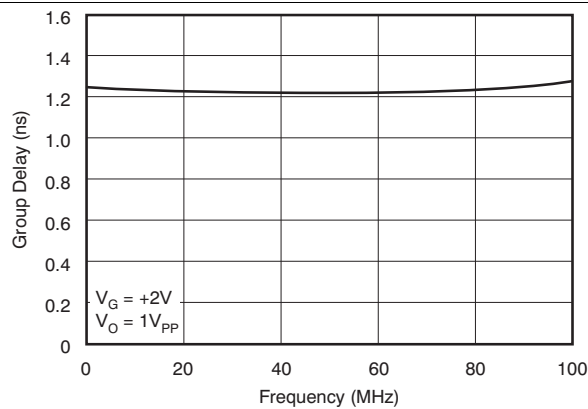


Figure 27. Group Delay vs Frequency

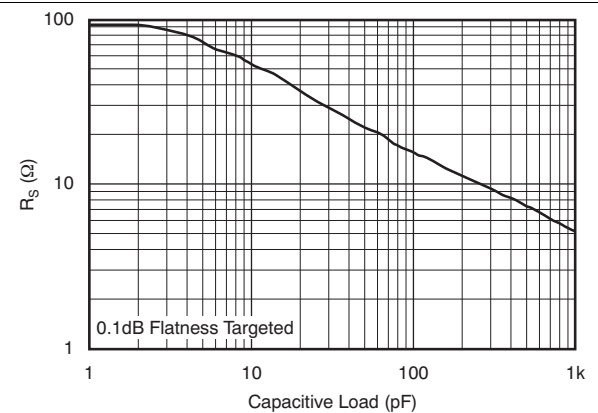


Figure 28. Recommended  $R_S$  vs Capacitive Load

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## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V_{MAX}} = 6\text{ dB}$ (continued)

At  $T_A = 25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 453\ \Omega$ ,  $R_G = 453\ \Omega$ ,  $V_G = 2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.

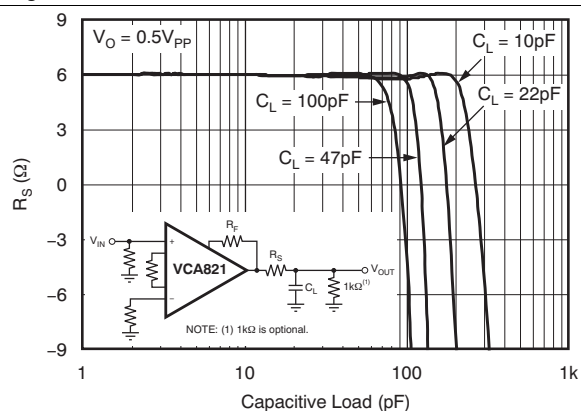


Figure 29. Frequency Response vs Capacitive Load

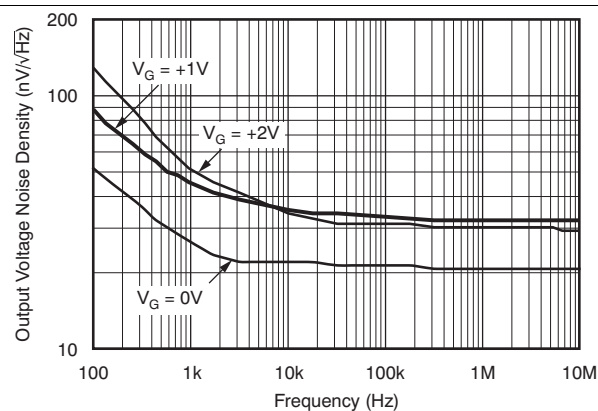


Figure 30. Output Voltage Noise Density

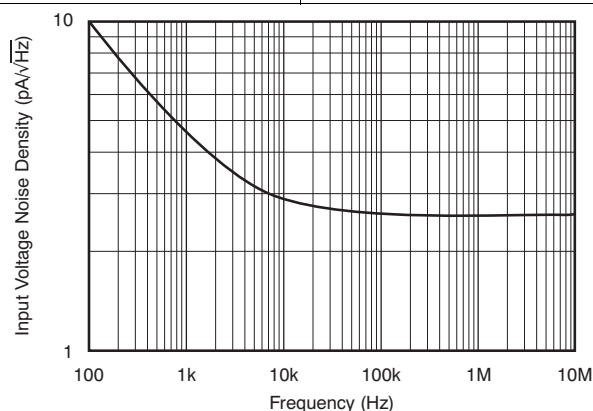
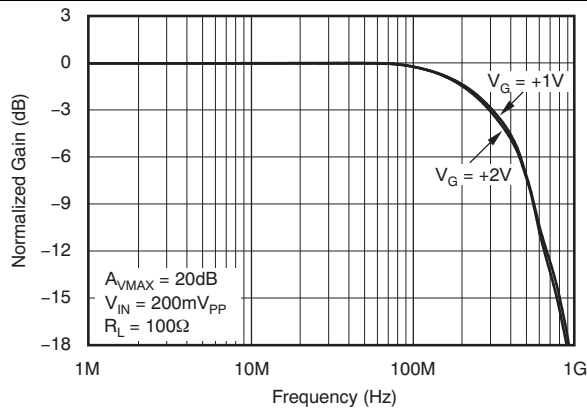


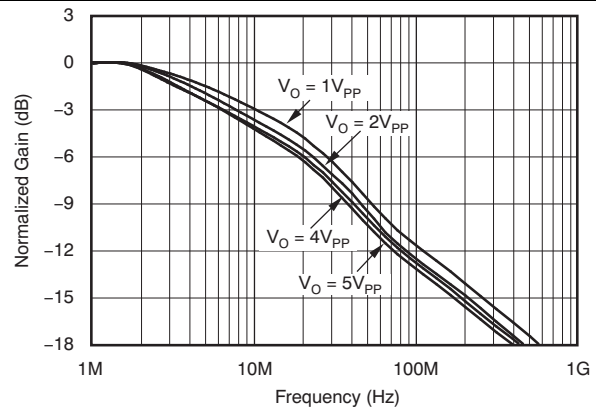
Figure 31. Input Current Noise Density

## 7.9 Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V\text{MAX}} = 20\text{ dB}$

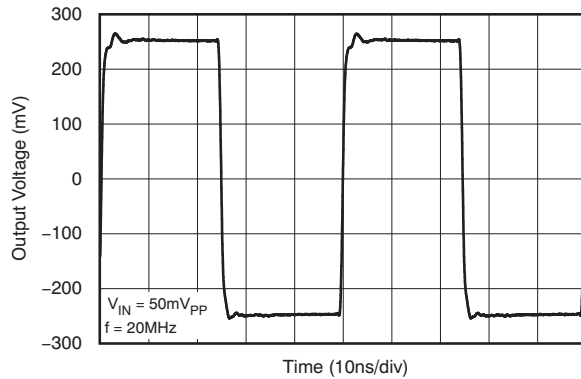
At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{\text{IN}}$  = single-ended input on  $+V_{\text{IN}}$  with  $-V_{\text{IN}}$  at ground, unless otherwise noted.



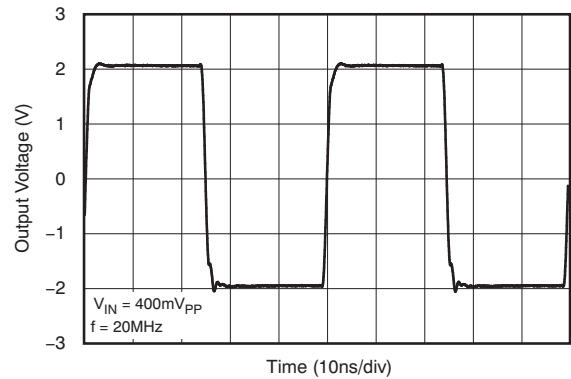
**Figure 32. Small-Signal Frequency Response**



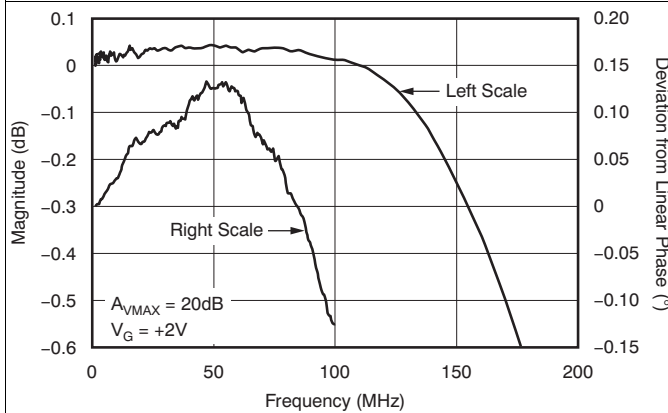
**Figure 33. Large-Signal Frequency Response**



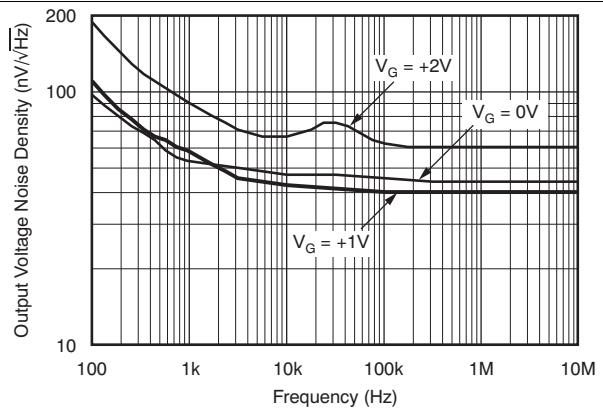
**Figure 34. Small-Signal Pulse Response**



**Figure 35. Large-Signal Pulse Response**



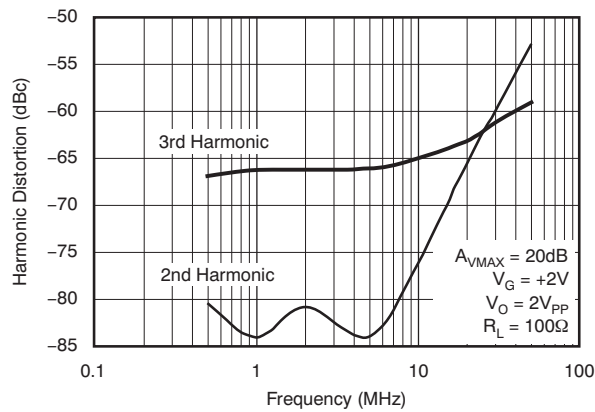
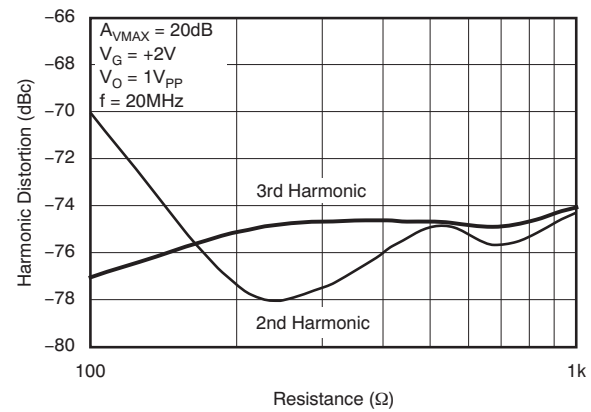
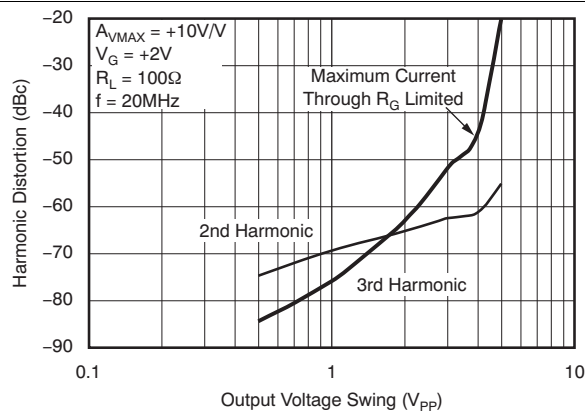
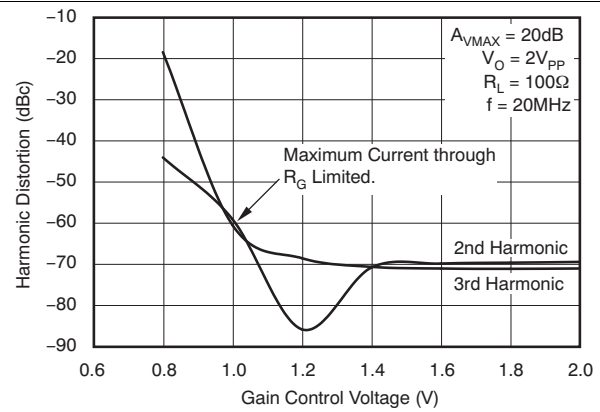
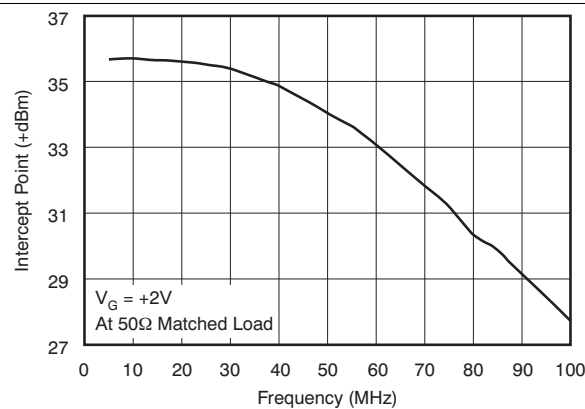
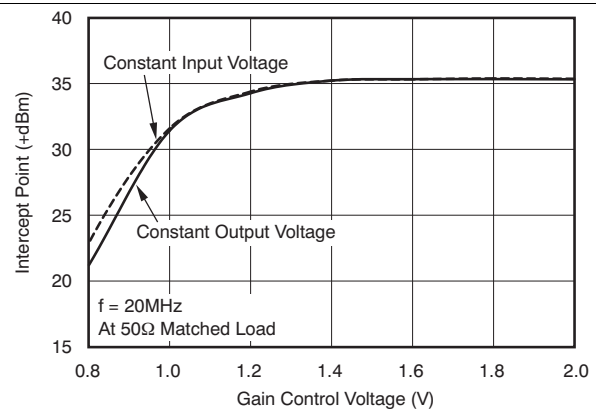
**Figure 36. Gain Flatness, Deviation From Linear Phase**



**Figure 37. Output Voltage Noise Density**

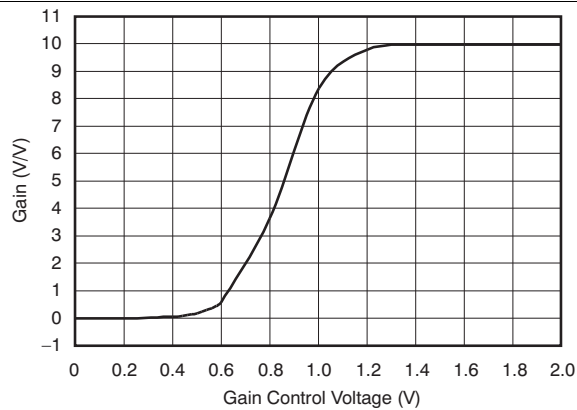
## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{VMAX} = 20\text{ dB}$ (continued)

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, unless otherwise noted.

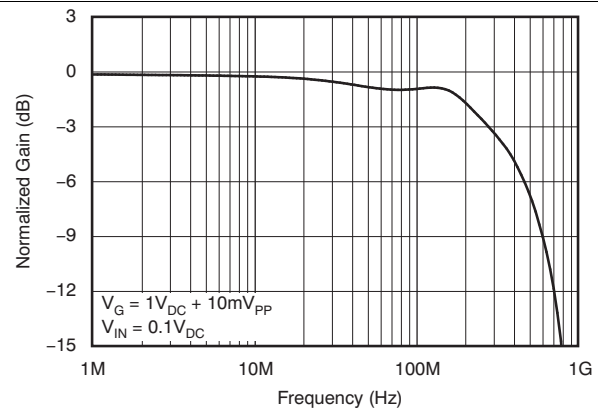

**Figure 38. Harmonic Distortion vs Frequency**

**Figure 39. Harmonic Distortion vs Load Resistance**

**Figure 40. Harmonic Distortion vs Output Voltage**

**Figure 41. Harmonic Distortion vs Gain Control Voltage**

**Figure 42. Two-Tone, Third-Order Intermodulation Intercept**

**Figure 43. Two-Tone, Third-Order Intermodulation Intercept vs Gain Control Voltage**

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{VMAX} = 20\text{ dB}$ (continued)

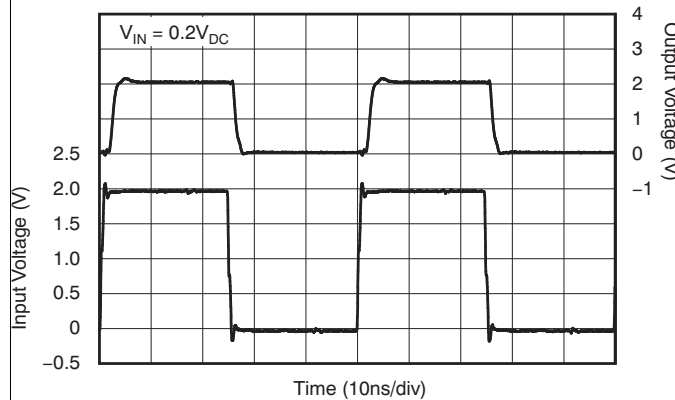
At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{IN} = \text{single-ended input on } +V_{IN} \text{ with } -V_{IN} \text{ at ground}$ , unless otherwise noted.



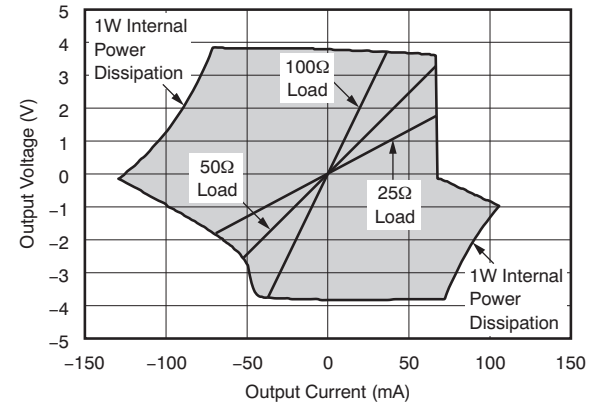
**Figure 44. Gain vs Gain Control Voltage**



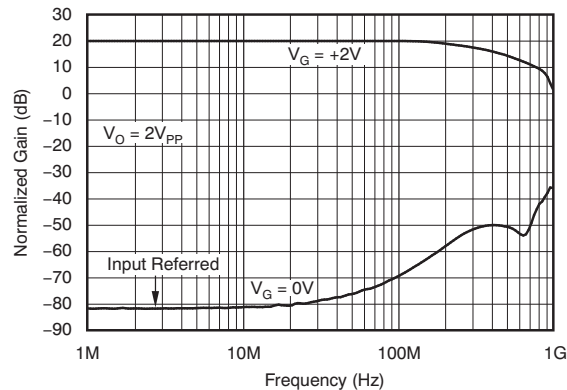
**Figure 45. Gain Control Frequency Response**



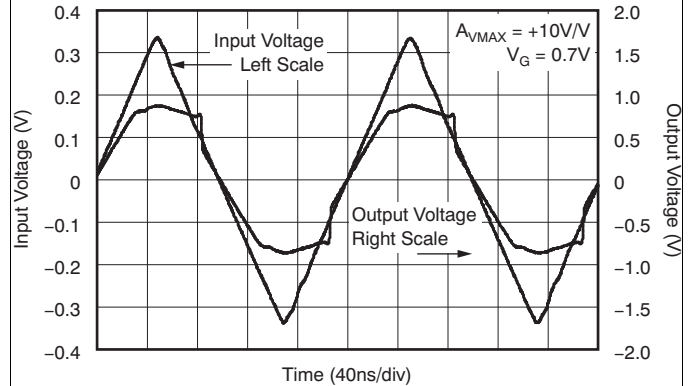
**Figure 46. Gain Control Pulse Response**



**Figure 47. Output Voltage and Current Limitations**



**Figure 48. Fully-Attenuated Response**



**Figure 49.  $I_{RG}$  Limited Overdrive Recovery**

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V_{MAX}} = 20\text{ dB}$ (continued)

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 80\ \Omega$ ,  $V_G = +2\text{ V}$ , and  $V_{IN} = \text{single-ended input on } +V_{IN} \text{ with } -V_{IN} \text{ at ground, unless otherwise noted.}$

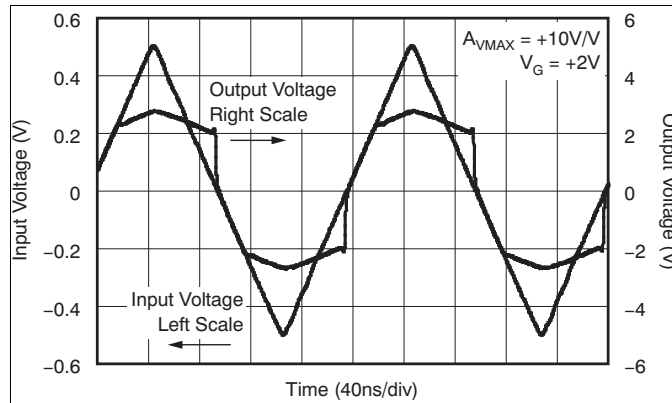


Figure 50. Output Limited Overdrive Recovery

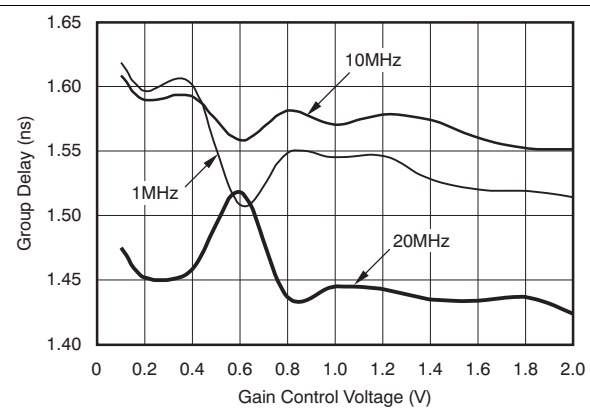


Figure 51. Group Delay vs Gain Control Voltage

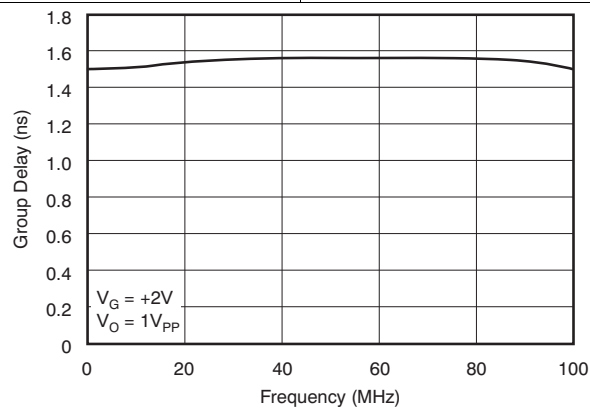
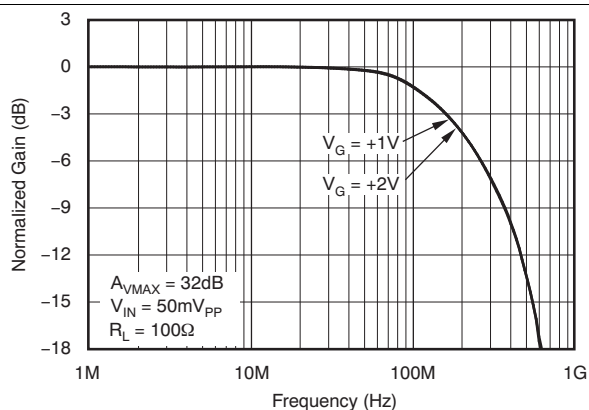


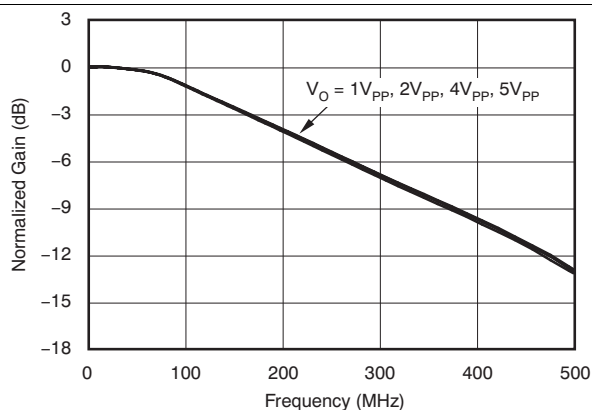
Figure 52. Group Delay vs Frequency

## 7.10 Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V\text{MAX}} = 32\text{ dB}$

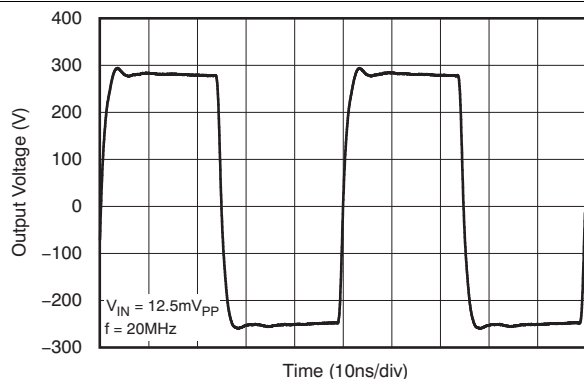
At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 18\ \Omega$ ,  $V_G = +2\text{ V}$ ,  $V_{\text{IN}}$  = single-ended input on  $+V_{\text{IN}}$  with  $-V_{\text{IN}}$  at ground, and SOIC package, unless otherwise noted.



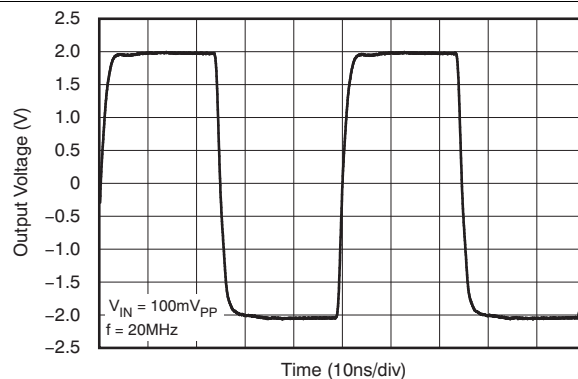
**Figure 53. Small-Signal Frequency Response**



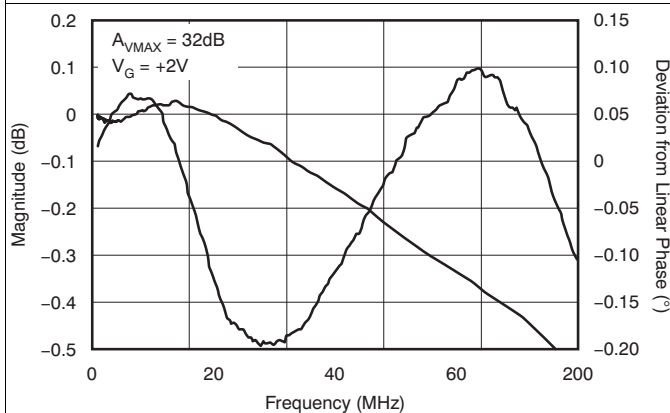
**Figure 54. Large-Signal Frequency Response**



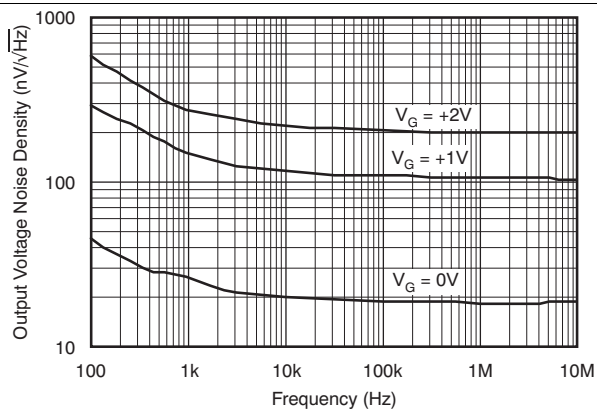
**Figure 55. Small-Signal Pulse Response**



**Figure 56. Large-Signal Pulse Response**



**Figure 57. Gain Flatness, Deviation From Linear Phase**



**Figure 58. Output Voltage Noise Density**

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### Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V_{MAX}} = 32\text{ dB}$ (continued)

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 18\ \Omega$ ,  $V_G = +2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.

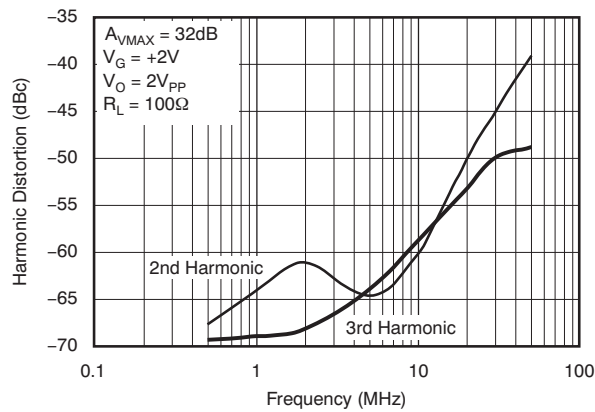


Figure 59. Harmonic Distortion vs Frequency

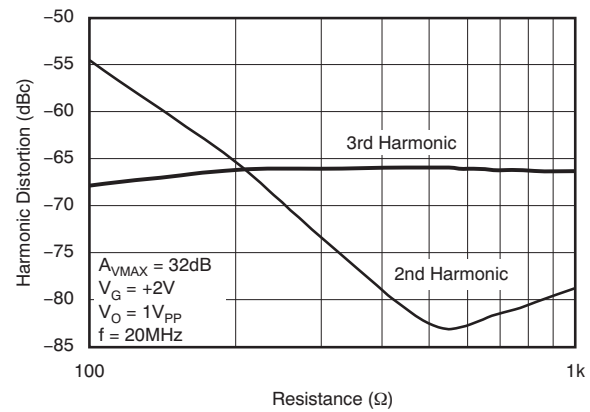


Figure 60. Harmonic Distortion vs Load Resistance

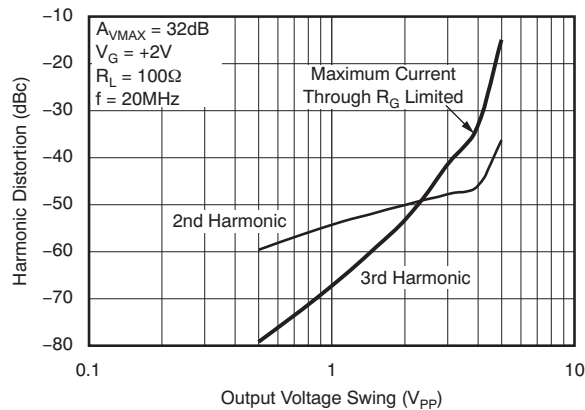


Figure 61. Harmonic Distortion Output Voltage

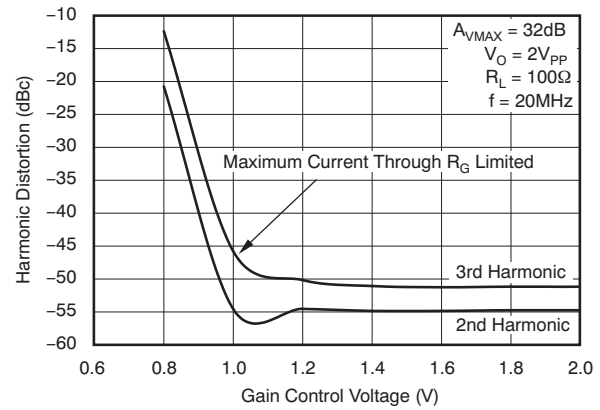


Figure 62. Harmonic Distortion vs Gain Control Voltage

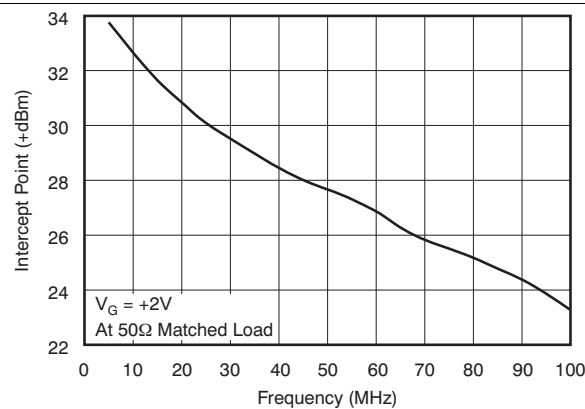


Figure 63. Two-Tone, Third-Order Intermodulation Intercept

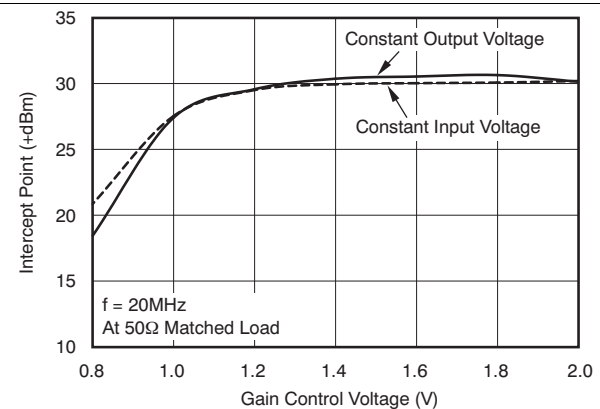


Figure 64. Two-Tone, Third-Order Intermodulation Intercept vs Gain Control Voltage

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{VMAX} = 32\text{ dB}$ (continued)

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 18\ \Omega$ ,  $V_G = +2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.

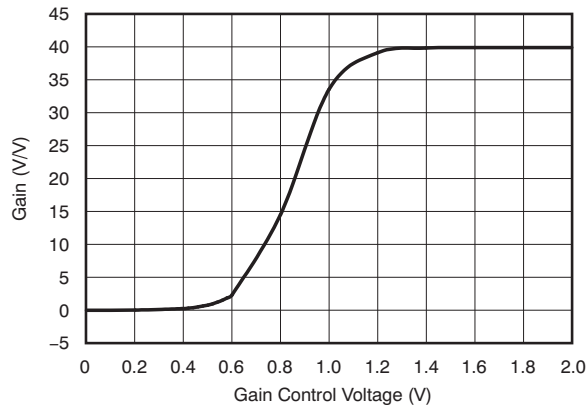


Figure 65. Gain vs Gain Control Voltage

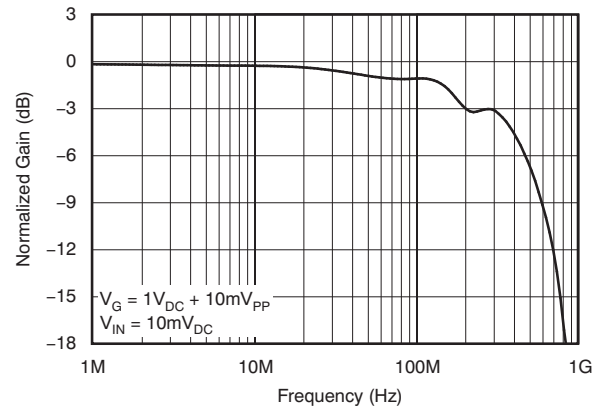


Figure 66. Gain Control Frequency Response

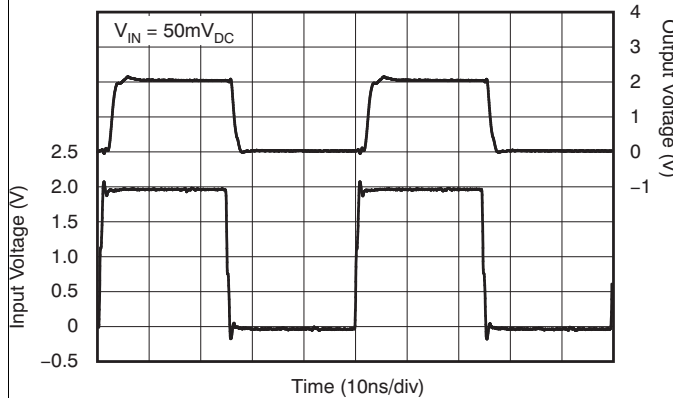


Figure 67. Gain Control Pulse Response

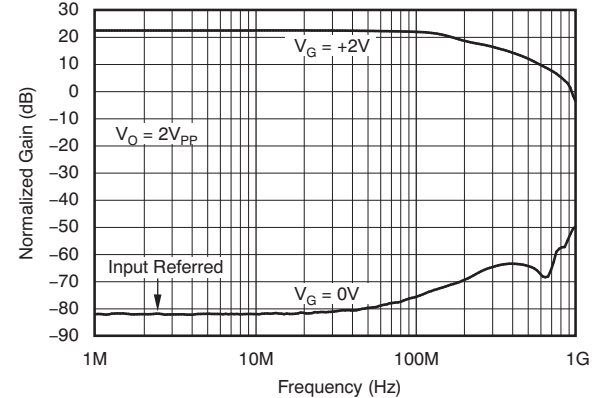


Figure 68. Fully Attenuated Response

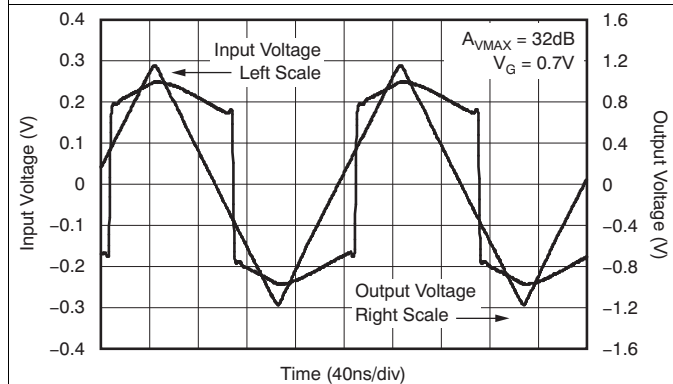


Figure 69.  $I_{RG}$  Limited Overdrive Recovery

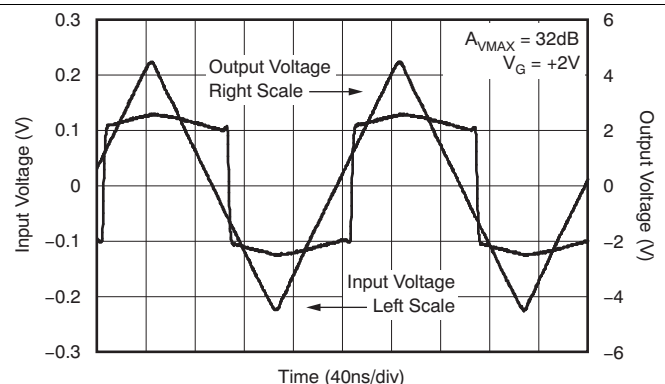
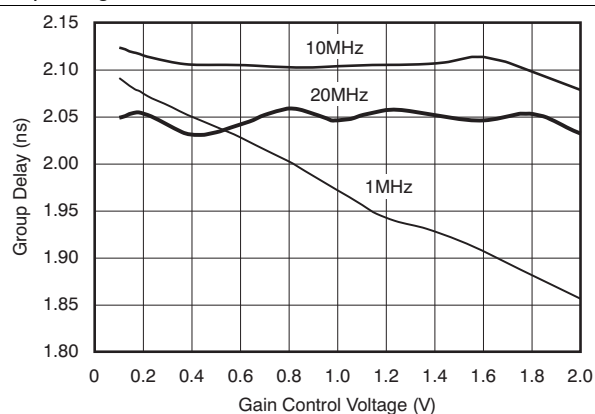


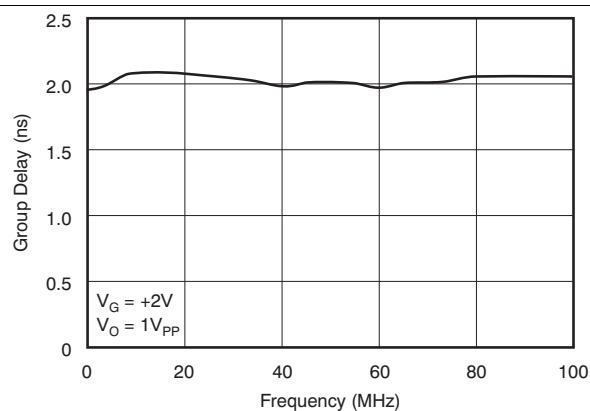
Figure 70. Output Limited Overdrive Recovery

## Typical Characteristics: $V_S = \pm 5\text{ V}$ , $A_{V_{MAX}} = 32\text{ dB}$ (continued)

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 100\ \Omega$ ,  $R_F = 402\ \Omega$ ,  $R_G = 18\ \Omega$ ,  $V_G = +2\text{ V}$ ,  $V_{IN}$  = single-ended input on  $+V_{IN}$  with  $-V_{IN}$  at ground, and SOIC package, unless otherwise noted.

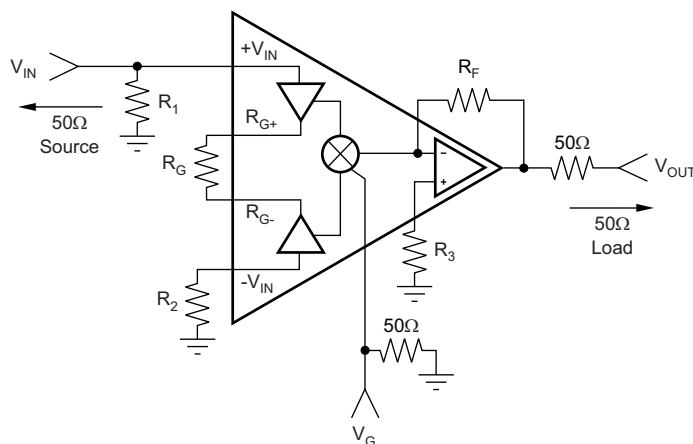


**Figure 71. Group Delay vs Gain Control Voltage**



**Figure 72. Group Delay vs Frequency**

## 8 Parameter Measurement Information



**Figure 73. Test Circuit**

## 9 Detailed Description

### 9.1 Overview

The VCA821 is a voltage controlled variable gain amplifier with differential inputs and a single ended output. The maximum gain is set by external resistors while the gain range is controlled by an external analog voltage. The maximum gain is designed for gains of 2 V/V up to 100 V/V and the analog control allows a gain range of over 40 dB. The VCA821 Input consists of two buffers which, together create a fully symmetrical, high impedance differential input with a typical common mode rejection of 80 dB. The gain set resistor is connected between the two input buffer output pins, so that the input impedance is independent of the gain settings. The bipolar inputs have a input voltage range of +1.6 V and –2.1 V on  $\pm 5$  V supplies. The amplifier maximum gain is set by external resistors, but the internal gain control circuit is controlled by a continuously variable, analog voltage. The gain control is a multiplier stage which is linear in dB. The gain control input pin operates over a voltage range of 0 V to 2 V. The VCA821 contains a high speed, high current output buffer. The output stage can typically swing  $\pm 3.9$  V and source/sink  $\pm 90$  mA. The VCA821 can be operated over a voltage range of  $\pm 3.5$  V to  $\pm 6$  V.

### 9.2 Feature Description

The VCA821 can be operated with both single ended or differential input signals. The inputs present consistently high impedance across all gain configurations. By using an analog control signal the amplifier gain is continuously variable for smooth, glitch free gain changes. With a large signal bandwidth of 320 MHz and a slew rate of 2500 V/ $\mu$ s the VCA821 offers linear performance over a wide range of signal amplitudes and gain settings. The low impedance/high current output buffer can drive loads ranging from low impedance transmission lines to high-impedance, switched-capacitor analog to digital converters. By using closely matched internal components the VCA821 offers gain accuracy of  $\pm 0.3$  dB.

### 9.3 Device Functional Modes

The VCA821 functions as a differential input, single-ended output variable gain amplifier. This functional mode is enabled by applying power to the amplifier supply pins and is disabled by turning the power off.

The gain is continuously variable through the analog gain control input. While the gain range is fixed the maximum gain is set by two external components,  $R_f$  and  $R_g$  as shown in the [Figure 73](#). The maximum gain is equal to  $2 \times (R_f / R_g)$ . This gain is achieved with a 2-V voltage on the gain adjust pin VG. As the voltage decreases on the VG pin, the gain decreases in a linear in dB fashion with over 40 dB of gain range from 2-V to 0-V control voltage.

As with most other differential input amplifiers, inputs can be applied to either one or both of the amplifier inputs. The amplifier gain is controlled through the gain control pin.

## Device Functional Modes (continued)

### 9.3.1 Maximum Gain of Operation

This section describes the use of the VCA821 device in a fixed-gain application in which the  $V_G$  control pin is set at  $V_G = +1$  V. The tradeoffs described here are with bandwidth, gain, and output voltage range.

In the case of an application that does not make use of the  $V_{GAIN}$  but requires some other characteristic of the VCA821 device, the  $R_G$  resistor must be set so that the maximum current flowing through the resistance  $I_{RG}$  is less than  $\pm 2.6$  mA typical, or  $5.2$  mA<sub>PP</sub> as defined in the [Electrical Characteristics](#) table and must follow [Equation 1](#).

$$I_{RG} = \frac{V_{OUT}}{A_{VMAX} \times R_G} \quad (1)$$

As [Equation 1](#) illustrates, when the output dynamic range and maximum gain are defined, the gain resistor is set. This gain setting in turn affects the bandwidth because to achieve the gain (and with a set gain element), the feedback element of the output stage amplifier is set as well. Keeping in mind that the output amplifier of the VCA821 device is a current-feedback amplifier, the larger the feedback element, the lower the bandwidth because the feedback resistor is the compensation element.

Limiting the discussion to the input voltage only and ignoring the output voltage and gain, [Figure 1](#) illustrates the tradeoff between the input voltage and the current flowing through the gain resistor.

### 9.3.2 Output Current and Voltage

The VCA821 device provides output voltage and current capabilities that are unsurpassed in a low-cost monolithic VCA. Under no-load conditions at  $+25^\circ\text{C}$ , the output voltage typically swings closer than 1 V to either supply rails; the  $+25^\circ\text{C}$  swing limit is within 1.2 V of either rails. Into a  $15\text{-}\Omega$  load (the minimum tested load), it is tested to deliver more than  $\pm 90$  mA.

The specifications described above, though familiar in the industry, consider voltage and current limits separately. In many applications, it is the voltage  $\times$  current, or *V-I product*, that is more relevant to circuit operation. Refer to the *Output Voltage and Current Limitations* plot ([Figure 47](#)) in the [Typical Characteristics:  \$V\_S = \pm 5\$  V,  \$A\_{VMAX} = 20\$  dB](#). The X- and Y-axes of this graph show the zero-voltage output current limit and the zero-current output voltage limit, respectively. The four quadrants give a more detailed view of the VCA821 device output drive capabilities, noting that the graph is bounded by a *safe operating area* of 1-W maximum internal power dissipation. Superimposing resistor load lines onto the plot shows that the VCA821 device can drive  $\pm 2.5$  V into  $25\text{ }\Omega$  or  $\pm 3.5$  V into  $50\text{ }\Omega$  without exceeding the output capabilities or the 1-W dissipation limit. A  $100\text{-}\Omega$  load line (the standard test circuit load) shows the full  $\pm 3.9\text{-V}$  output swing capability, as shown in the [Typical Characteristics](#).

The minimum specified output voltage and current over-temperature are set by worst-case simulations at the cold temperature extreme. Only at cold startup do the output current and voltage decrease to the numbers shown in the [Electrical Characteristics](#) table. As the output transistors deliver power, the respective junction temperatures increase, thereby increasing the available output voltage swing and output current.

In steady-state operation, the available output voltage and current are always greater than the temperature shown in the over-temperature specifications because the output stage junction temperatures are higher than the specified operating ambient.

### 9.3.3 Input Voltage Dynamic Range

The VCA821 device has a input dynamic range limited to  $+1.6$  V and  $-2.1$  V. Increasing the input voltage dynamic range can be done by using an attenuator network on the input. If the VCA821 device is trying to regulate the amplitude at the output, such as in an AGC application, the input voltage dynamic range is directly proportional to [Equation 2](#).

$$V_{IN(PP)} = R_G \times I_{RG(PP)} \quad (2)$$

As such, for unity-gain or under-attenuated conditions, the input voltage must be limited to the CMIR of  $\pm 1.6$  V ( $3.2V_{PP}$ ) and the current ( $I_{RG}$ ) must flow through the gain resistor,  $\pm 2.6$  mA ( $5.2\text{mA}_{PP}$ ). This configuration sets a minimum value for  $R_E$  such that the gain resistor must be greater than [Equation 3](#).

## Device Functional Modes (continued)

$$R_{GMIN} = \frac{3.2V_{PP}}{5.2mA_{PP}} = 615.4\Omega \quad (3)$$

Values lower than 615.4  $\Omega$  are gain elements that result in reduced input range, as the dynamic input range is limited by the current flowing through the gain resistor  $R_G$  ( $I_{RG}$ ). If the  $I_{RG}$  current limits the performance of the circuit, the input stage of the VCA821 device goes into overdrive, resulting in limited output voltage range. Such  $I_{RG}$ -limited overdrive conditions are shown in Figure 49 for the gain of 20 dB and Figure 69 for the 32-dB gain.

### 9.3.4 Output Voltage Dynamic Range

With its large output current capability and its wide output voltage swing of  $\pm 3.9$ -V typical on 100- $\Omega$  load, it is easy to forget other types of limitations that the VCA821 device can encounter. For these limitations, careful analysis must be done to avoid input stage limitation: either voltage or  $I_{RG}$  current.

#### NOTE

If control pin  $V_G$  varies, the gain limitation may affect other aspects of the circuit.

### 9.3.5 Bandwidth

The output stage of the VCA821 device is a wideband current-feedback amplifier. As such, the feedback resistance is the compensation of the last stage. Reducing the feedback element and maintaining the gain constant limits the useful range of  $I_{RG}$ , and therefore, reduces the gain adjust range. For a given gain, reducing the gain element limits the maximum achievable output voltage swing.

### 9.3.6 Offset Adjustment

As a result of the internal architecture used on the VCA821 device, the output offset voltage originates from the output stage and from the input stage and multiplier core. Figure 74 shows how to compensate both sources of the output offset voltage. Use this procedure to compensate the output offset voltage: starting with the output stage compensation, set  $V_G = -1$  V to eliminate all offset contribution of the input stage and multiplier core. Adjust the output stage offset compensation potentiometer. Finally, set  $V_G = +1$  V to the maximum gain and adjust the input stage and multiplier core potentiometer. This procedure effectively eliminates all offset contribution at the maximum gain. Because adjusting the gain modifies the contribution of the input stage and the multiplier core, some residual output offset voltage remains.

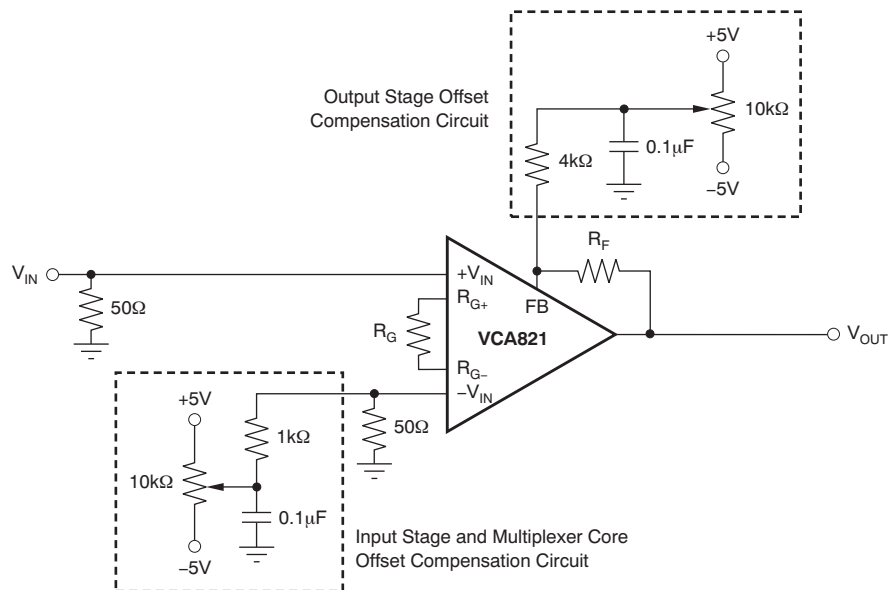


Figure 74. Adjusting the Input and Output Voltage Sources

## Device Functional Modes (continued)

### 9.3.7 Noise

The VCA821 device offers 6 nV/√Hz input-referred voltage noise density at a gain of 20 dB and 2.6 pA/√Hz input-referred current noise density. The input-referred voltage noise density considers that all noise terms (except the input current noise but including the thermal noise of both the feedback resistor and the gain resistor) are expressed as one term.

This model is formulated in [Equation 4](#) and [Figure 88](#).

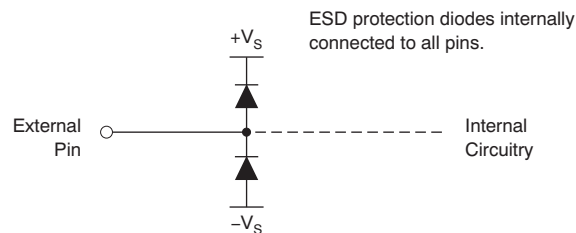
$$e_o = A_{VMAX} \times \sqrt{2 \times (R_s \times i_n)^2 + e_n^2 + 2 \times 4kTR_s} \quad (4)$$

A more complete model is shown in [Figure 89](#). For additional information on this model and the actual modeled noise terms, please contact the High-Speed Product Application Support team at [www.ti.com](http://www.ti.com).

#### 9.3.7.1 Input and ESD Protection

The VCA821 device is built using a very high-speed complementary bipolar process. The internal junction breakdown voltages are relatively low for these very small geometry devices. These breakdowns are reflected in the [Absolute Maximum Ratings](#) table.

All pins on the VCA821 device are internally protected from ESD by means of a pair of back-to-back reverse-biased diodes to either power supply, as shown in [Figure 75](#). These diodes begin to conduct when the pin voltage exceeds either power supply by about 0.7 V. This situation can occur with loss of the amplifier power supplies while a signal source is still present. The diodes can typically withstand a continuous current of 30 mA without destruction. To ensure long-term reliability, however, diode current should be externally limited to 10 mA whenever possible.



**Figure 75. Internal ESD Protection**

## 10 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

The VCA821 has flexible maximum gain which is set by the  $R_f$  and  $R_g$  resistors shown in [Figure 73](#). The maximum gain is equal to  $2x (R_f / R_g)$ . This gain is achieved with a 2-V voltage on the gain adjust pin VG. As the voltage decreases on the VG pin, the gain decreases in a linear in dB fashion with over 40 dB of gain range from 2-V to 0-V control voltage.

#### 10.1.1 Design-In Tools

##### 10.1.1.1 Demonstration Boards

Two printed circuit boards (PCBs) are available to assist in the initial evaluation of circuit performance using the VCA821 device in the two package options. Both of these are offered free of charge as unpopulated PCBs that are delivered with a user's guide. The summary information for these fixtures is shown in [Table 1](#).

**Table 1. EVM Ordering Information**

| PRODUCT    | PACKAGE  | BOARD PART NUMBER | LITERATURE NUMBER       |
|------------|----------|-------------------|-------------------------|
| VCA821ID   | SOIC-14  | DEM-VCA-SO-1B     | <a href="#">SBOU050</a> |
| VCA821IDGS | VSSOP-10 | DEM-VCA-VSSOP-1A  | <a href="#">SBOU051</a> |

The demonstration fixtures can be requested at the Texas Instruments web site ([www.ti.com](http://www.ti.com)) through the VCA821 device product folder.

##### 10.1.1.2 Macromodels and Applications Support

Computer simulation of circuit performance using SPICE is often useful when analyzing the performance of analog circuits and systems. This principle is particularly true for video and RF amplifier circuits where parasitic capacitance and inductance can play a major role in circuit performance. A [SPICE model](#) for the VCA821 device is available through the TI web page. The applications group is also available for design assistance. The models available from TI predict typical small-signal ac performance, transient steps, DC performance, and noise under a wide variety of operating conditions. The models include the noise terms found in the electrical specifications of the relevant product data sheet.

##### 10.1.1.3 Operating Suggestions

Operating the VCA821 optimally for a specific application requires trade-offs between bandwidth, input dynamic range and the maximum input voltage, the maximum gain of operation and gain, output dynamic range and the maximum input voltage, the package used, loading, and layout and bypass recommendations. The [Typical Characteristics](#) have been defined to cover as much ground as possible to describe the VCA821 operation. There are four sections in the [Typical Characteristics](#):

- $V_S = \pm 5\text{ V}$  [DC Parameters](#) and  $V_S = \pm 5\text{ V}$  [DC and Power-Supply Parameters](#), which include DC operation and the intrinsic limitation of a VCA821 device design
- $V_S = \pm 5\text{ V}$ ,  $A_{V_{MAX}} = 6\text{ dB}$  [Gain of 6dB Operation](#)
- $V_S = \pm 5\text{ V}$ ,  $A_{V_{MAX}} = 20\text{ dB}$  [Gain of 20dB Operation](#)
- $V_S = \pm 5\text{ V}$ ,  $A_{V_{MAX}} = 32\text{ dB}$  [Gain of 32dB Operation](#)

Where the Typical Characteristics describe the actual performance that can be achieved by using the amplifier properly, the following sections describe in detail the trade-offs needed to achieve this level of performance.

## Application Information (continued)

### 10.1.1.4 Package Considerations

The VCA821 device is available in both SOIC-14 and VSSOP-10 packages. Each package has, for the different gains used in the typical characteristics, different values of  $R_F$  and  $R_G$  in order to achieve the same performance detailed in the [Electrical Characteristics](#) table.

[Figure 76](#) shows a test gain circuit for the VCA821 device. [Table 2](#) lists the recommended configuration for the SOIC-14 and VSSOP-10 packages.

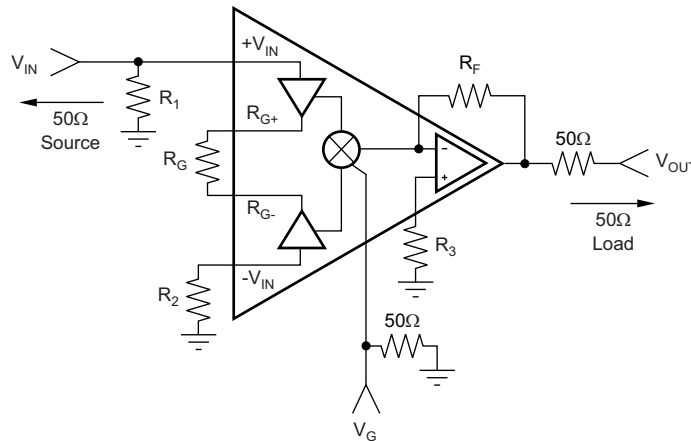


Figure 76. Test Circuit

Table 2. SOIC-14 and VSSOP-10  $R_F$  and  $R_G$  Configurations

|       | G = 2        | G = 10       | G = 40       |
|-------|--------------|--------------|--------------|
| $R_F$ | 453 $\Omega$ | 402 $\Omega$ | 402 $\Omega$ |
| $R_G$ | 453 $\Omega$ | 80 $\Omega$  | 18 $\Omega$  |

There are no differences between the packages in the recommended values for the gain and feedback resistors. However, the bandwidth for the VCA821IDGS (VSSOP-10 package) is lower than the bandwidth for the VCA821ID (SOIC-14 package). This difference is true for all gains, but especially true for gains greater than 5 V/V, as can be seen in [Figure 77](#) and [Figure 78](#).

### NOTE

The scale must be changed to a linear scale to view the details.

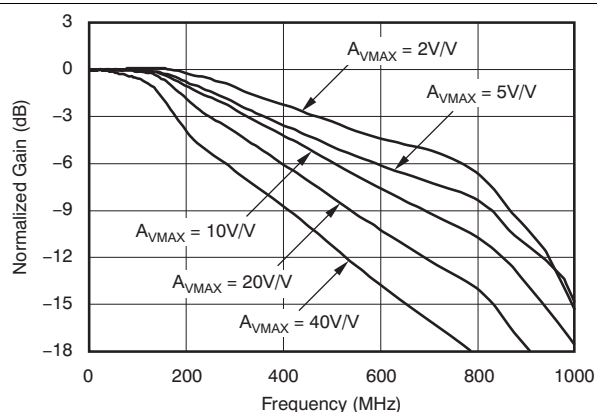


Figure 77. SOIC-14 Recommended  $R_F$  and  $R_G$  vs  $A_{VMAX}$

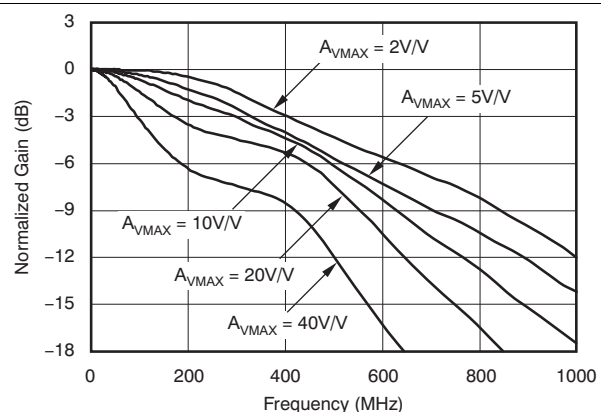
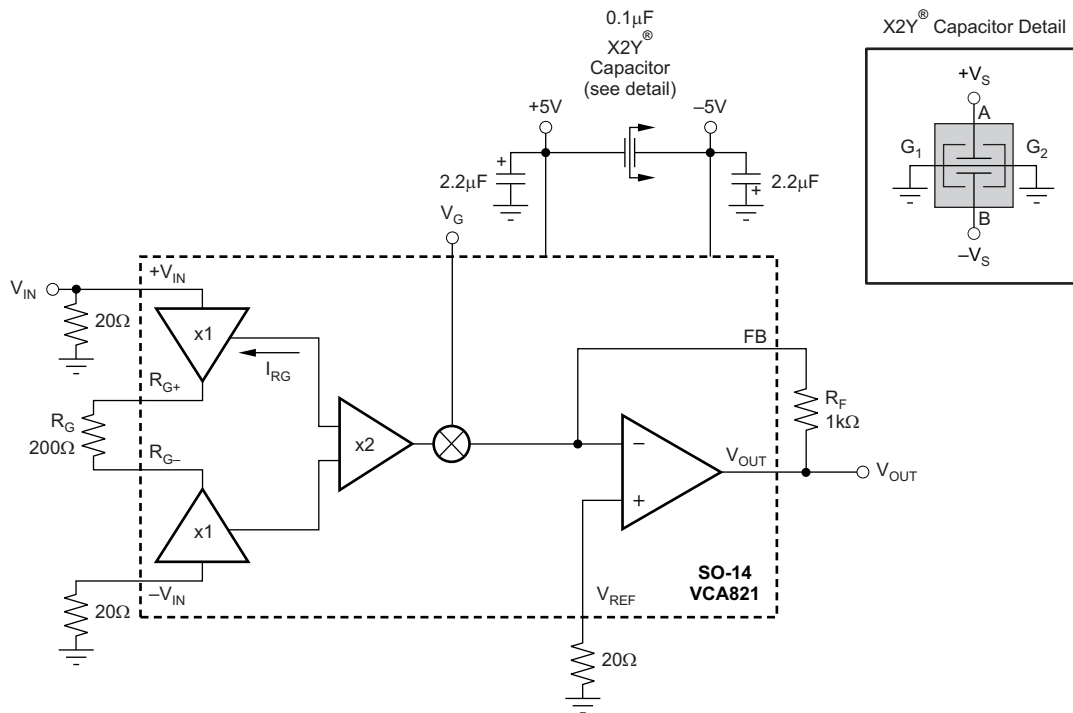


Figure 78. VSSOP-10 Recommended  $R_F$  and  $R_G$  vs  $A_{VMAX}$

## 10.2 Typical Applications

### 10.2.1 Wideband Variable-Gain Amplifier Operation Application



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Figure 79. DC-Coupled,  $A_{VMAX} = 20$  dB, Bipolar Supply Specification and Test Circuit

#### 10.2.1.1 Design Requirements

The design shown in Figure 79 requires a single-ended input, continuously variable gain control and a single-ended output. This configuration is used to achieve the best performance with a bipolar supply. This circuit also requires a maximum gain of 10 V/V and low noise.

#### 10.2.1.2 Detailed Design Procedure

The VCA821 device provides an exceptional combination of high output power capability with a wideband, greater than 40-dB gain adjust range, linear in dB variable gain amplifier. The VCA821 device input stage places the transconductance element between two input buffers, using the output currents as the forward signal. As the differential input voltage rises, a signal current is generated through the gain element. This current is then mirrored and gained by a factor of two before reaching the multiplier. The other input of the multiplier is the voltage gain control pin,  $V_G$ . Depending on the voltage present on  $V_G$ , up to two times the gain current is provided to the transimpedance output stage. The transimpedance output stage is a current-feedback amplifier providing high output current capability and high slew rate, 2500 V/μs. This exceptional full-power performance comes at the price of relatively high quiescent current (34 mA), but low input voltage noise for this type of architecture (6 nV/√Hz).

Figure 79 shows the DC-coupled, gain of +10 V/V, dual power-supply circuit used as the basis of the ±5-V *Electrical Characteristics* and *Typical Characteristics*. For test purposes, the input impedance is set to 50 Ω with a resistor to ground and the output impedance is set to 50 Ω with a series output resistor. Voltage swings reported in the *Electrical Characteristics* table are taken directly at the input and output pins, while output power (dBm) is at the matched 50-Ω load. For the circuit in Figure 79, the total effective load is 100 Ω || 1 kΩ.

## Typical Applications (continued)

### NOTE

For the SOIC-14 package, there is a voltage reference pin,  $V_{REF}$  (pin 9). For the SOIC-14 package, this pin must be connected to ground through a 20- $\Omega$  resistor in order to avoid possible oscillations of the output stage. In the VSSOP-10 package, this pin is internally connected and does not require such precaution.

An X2Y<sup>®</sup> capacitor has been used for power-supply bypassing. The combination of low inductance, high resonance frequency, and integration of three capacitors in one package (two capacitors to ground and one across the supplies) enables the VCA821 device to achieve the low second-harmonic distortion reported in the [Electrical Characteristics](#) table. More information on how the VCA821 device operates can be found in the [Operating Suggestions](#) section.

### 10.2.1.3 Application Curve

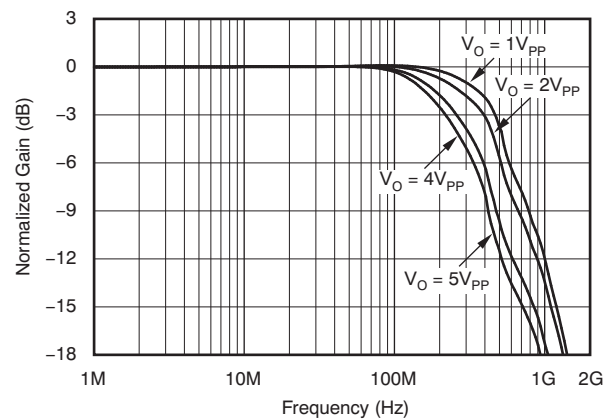
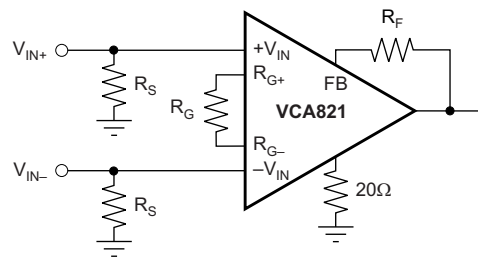


Figure 80. Large-Signal Frequency Response

## 10.2.2 Difference Amplifier Application



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Figure 81. Difference Amplifier

### 10.2.2.1 Design Requirements

For a difference amplifier, the design requirements are differential voltage gain, common mode rejection, and load drive capability. This circuit delivers differential gain of  $2 \cdot (R_F/R_G)$ , and CMRR as shown in [Figure 82](#).

### 10.2.2.2 Detailed Design Procedure

Because both inputs of the VCA821 device are high-impedance, a difference amplifier can be implemented without any major problem. [Figure 81](#) shows this implementation. This circuit provides excellent common-mode rejection ratio (CMRR) as long as the input is within the CMRR range of  $-2.1$  V to  $+1.6$  V.

## Typical Applications (continued)

### NOTE

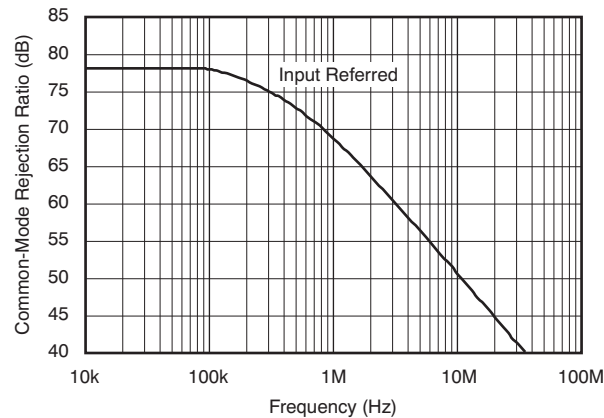
This circuit does not make use of the gain control pin,  $V_G$ . Also, it is recommended to choose  $R_S$  such that the pole formed by  $R_S$  and the parasitic input capacitance does not limit the bandwidth of the circuit.

Figure 82 shows the common-mode rejection ratio for this circuit implemented in a gain of 20 dB for  $V_G = +2$  V.

### NOTE

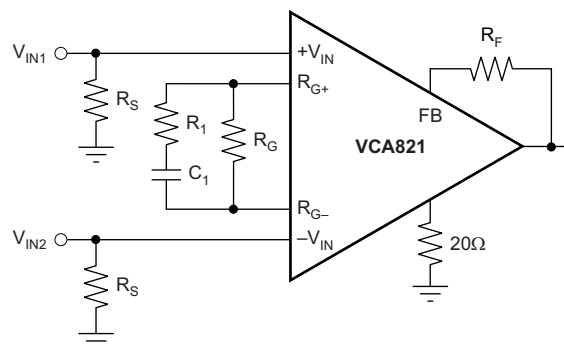
Because the gain control voltage is fixed and is normally set to +2 V, the feedback element can be reduced to increase the bandwidth. When reducing the feedback element, make sure that the VCA821 device is not limited by common-mode input voltage, the current flowing through  $R_G$ , or any other limitation described in this data sheet.

### 10.2.2.3 Application Curve



**Figure 82. Common-Mode Rejection Ratio**

### 10.2.3 Differential Equalizer Application



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**Figure 83. Differential Equalizer**

#### 10.2.3.1 Design Requirements

Signals that travel over a length of cable experience an attenuation that is proportional to the square root of the frequency. For this reason, a fixed bandwidth amplifier will not restore the original signal. To replicate the original signal, the higher frequency signal components require more gain. The circuit in Figure 83 has one stage of frequency shaping to help restore a signal transmitted along a cable. If needed, additional frequency shaping stages can be added as shown in Figure 84.

## Typical Applications (continued)

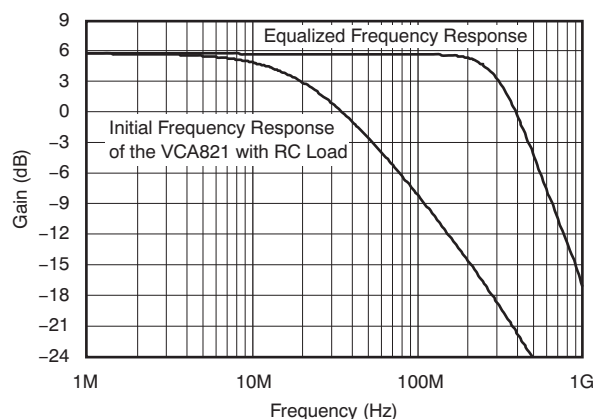
### 10.2.3.2 Detailed Design Procedure

If the application requires frequency shaping (the transition from one gain to another), the VCA821 device can be used advantageously because its architecture allows the application to isolate the input from the gain setting elements. Figure 83 shows an implementation of such a configuration. The transfer function is shown in Equation 5.

This transfer function has one pole,  $P_1$  (located at  $R_G C_1$ ), and one zero,  $Z_1$  (located at  $R_1 C_1$ ). When equalizing an RC load,  $R_L$  and  $C_L$ , compensate the pole added by the load located at  $R_L C_L$  with the zero  $Z_1$ . Knowing  $R_L$ ,  $C_L$ , and  $R_G$  allows the user to select  $C_1$  as a first step and then calculate  $R_1$ . Using  $R_L = 75\ \Omega$ ,  $C_L = 100\ \text{pF}$  and wanting the VCA821 device to operate at a gain of +2 V/V (which gives  $R_F = R_G = 453\ \Omega$ ) allows the user to select  $C_1 = 15.5\ \text{pF}$  to ensure a positive value for the resistor  $R_1$ . With all these values known, to achieve greater than 300-MHz bandwidth,  $R_1$  can be calculated to be  $20\ \Omega$ . Figure 84 shows the frequency response for both the initial, unequalized frequency response and the resulting equalized frequency response.

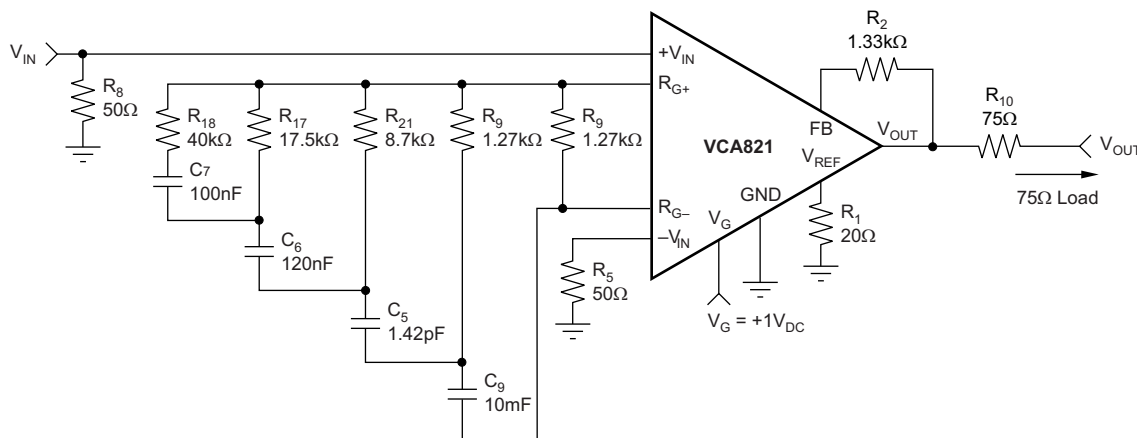
$$G = 2 \times \frac{R_F}{R_G} \times \frac{1 + sR_G C_1}{1 + sR_1 C_1} \quad (5)$$

### 10.2.3.3 Application Curve



**Figure 84. Differential Equalization of an RC Load**

## 10.2.4 Differential Cable Equalizer Application



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**Figure 85. Differential Cable Equalizer**

## Typical Applications (continued)

### 10.2.4.1 Design Requirements

Signals that travel over a length of cable experience an attenuation that is proportional to the square root of the frequency. For this reason, a fixed bandwidth amplifier will not restore the original signal. To replicate the original signal, the higher frequency signal components require more gain. The circuit in [Figure 85](#) has multiple stages of frequency shaping to help restore a signal transmitted along a cable. This circuit is similar to the one shown in [Figure 83](#), but is much more accurate in replicating the  $1/\sqrt{f}$  frequency response shape.

### 10.2.4.2 Detailed Design Procedure

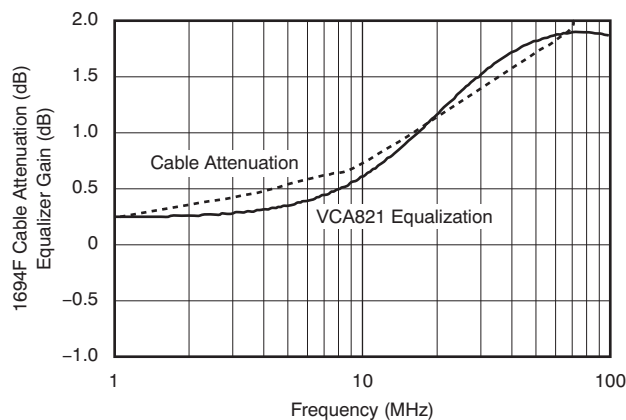
A differential cable equalizer can easily be implemented using the VCA821 device. An example of a cable equalization for 100 feet of Belden cable 1694F is illustrated in [Figure 84](#), with [Figure 86](#) showing the result for this implementation. This implementation has a maximum error of 0.2 dB from DC to 70 MHz.

#### NOTE

This implementation shows the cable attenuation side-by-side with the equalization in the same plot.

For a given frequency, the equalization function realized with the VCA821 device matches the cable attenuation. The circuit in [Figure 85](#) is a driver circuit. To implement a receiver circuit, the signal is received differentially between the  $+V_{IN}$  and  $-V_{IN}$  inputs.

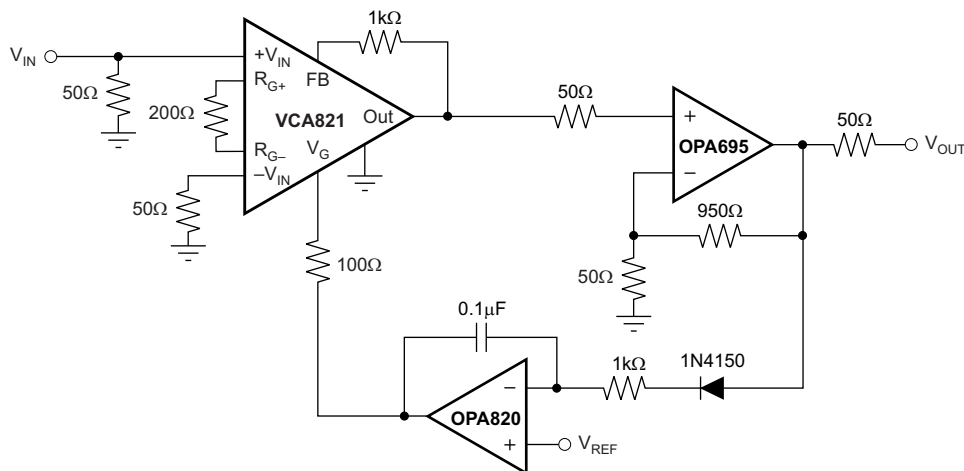
### 10.2.4.3 Application Curve



**Figure 86. Cable Attenuation vs Equalizer Gain**

## Typical Applications (continued)

### 10.2.5 AGC Loop Application



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**Figure 87. AGC Loop**

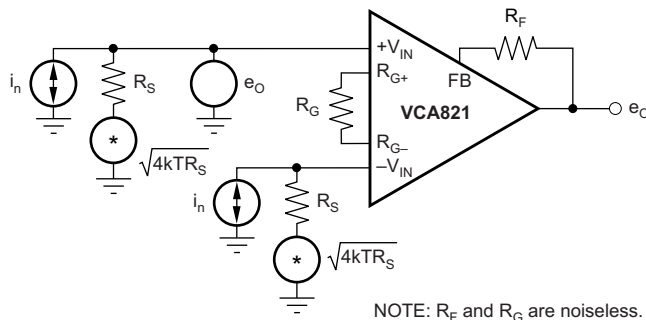
#### 10.2.5.1 Design Requirements

When dynamic signal amplitude correction is required, an AGC loop will provide real-time gain control. The requirements for this circuit are fast gain control response and linear in dB gain control. The time constant of the loop is set with the 0.1-μF capacitor and the 1-kΩ resistor. The OPA695 provides additional load driving capability.

#### 10.2.5.2 Detailed Design Procedure

In the typical AGC loop shown in [Figure 87](#), the [OPA695](#) device follows the [VCA821](#) device to provide 40 dB of overall gain. The output of the OPA695 device is rectified and integrated by an [OPA820](#) device to control the gain of the AGC loop. When the output level exceeds the reference voltage ( $V_{REF}$ ), the integrator ramps down reducing the gain of the AGC loop. Conversely, if the output is too small, the integrator ramps up increasing the net gain and the output voltage.

## 10.3 System Examples

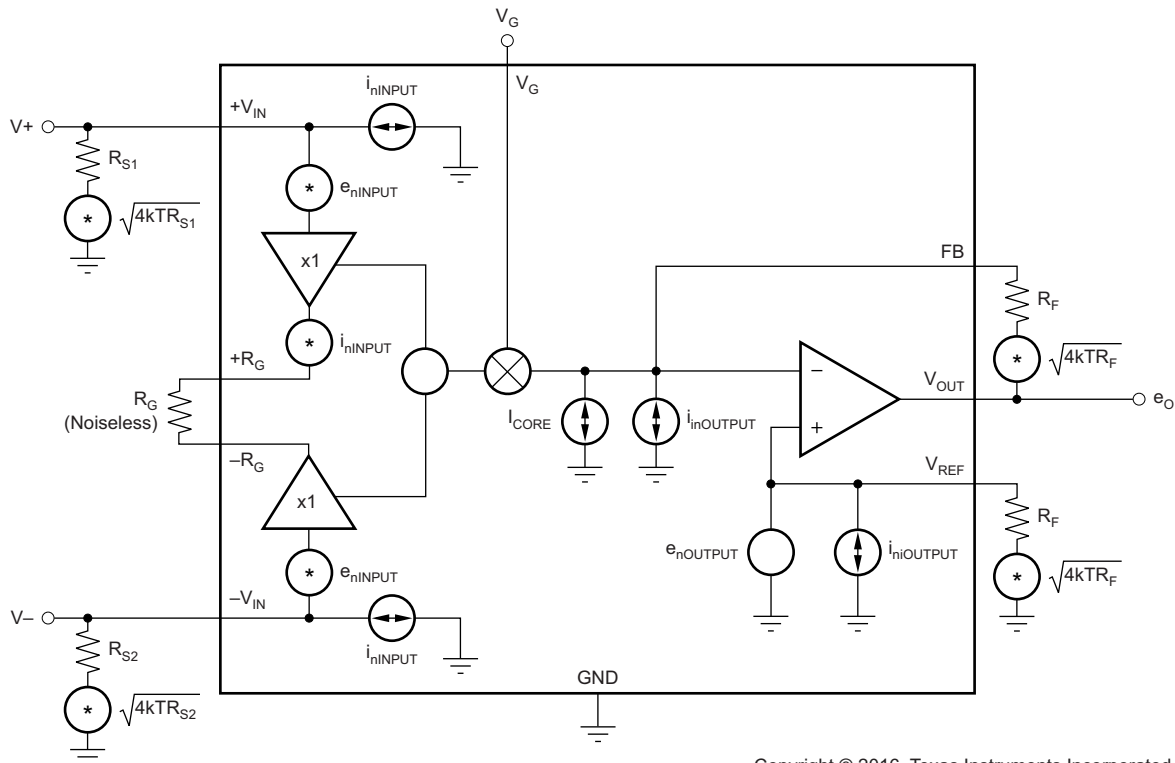


NOTE:  $R_F$  and  $R_G$  are noiseless.

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**Figure 88. Simple Noise Model**

## System Examples (continued)



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**Figure 89. Full Noise Model**

## 11 Power Supply Recommendations

High-speed amplifiers require low inductance power supply traces and low ESR bypass capacitors. The power supply voltage should be centered on the desired amplifier output voltage, so for ground referenced output signals, split supplies are required. The power supply voltage should be from 7 V to 12 V.

## 12 Layout

### 12.1 Layout Guidelines

Achieving optimum performance with a high-frequency amplifier such as the VCA821 device requires careful attention to printed circuit board (PCB) layout parasitics and external component types. Recommendations to optimize performance include the following:

1. **Minimize parasitic capacitance** to any AC ground for all of the signal I/O pins. This recommendation includes GND (pin 2). Parasitic capacitance on the output can cause instability on both the inverting input and the noninverting input, and it can react with the source impedance to cause unintentional band limiting. To reduce unwanted capacitance, a window around the signal I/O pins must be opened in all of the ground and power planes around those pins. Otherwise, ground and power planes must be unbroken elsewhere on the board. Place a small series resistance (greater than 25  $\Omega$ ) with the input pin connected to ground to help decouple package parasitics.
2. **Minimize the distance** (less than 0.25 inches, or 6.3 mm) from the power-supply pins to high-frequency 0.1- $\mu$ F decoupling capacitors. At the device pins, the ground and power plane layout must not be in close proximity to the signal I/O pins. Avoid narrow power and ground traces to minimize inductance between the pins and the decoupling capacitors. The power-supply connections must always be decoupled with these capacitors. Larger decoupling capacitors (2.2  $\mu$ F to 6.8  $\mu$ F), effective at lower frequencies, must also be used on the main supply pins. These capacitors can be placed somewhat farther from the device and may be shared among several devices in the same area of the PCB.
3. **Careful selection and placement** of external components preserves the high-frequency performance of the VCA821 device. Resistors must be a very low-reactance type. Surface-mount resistors work best and allow a tighter overall layout. Metal-film and carbon composition, axially-leaded resistors can also provide good high-frequency performance. Again, keep the leads and PCB trace length as short as possible. Never use wire-wound type resistors in a high-frequency application. Because the output pin is the most sensitive to parasitic capacitance, always position the series output resistor, if any, as close as possible to the output pin. Other network components, such as inverting or noninverting input termination resistors, must also be placed close to the package.
4. **Connections to other wideband devices** on the board may be made with short direct traces or through onboard transmission lines. For short connections, consider the trace and the input to the next device as a lumped capacitive load. Relatively wide traces (50 mils to 100 mils, or 1.27 mm to 2.54 mm) must be used, preferably with ground and power planes opened up around them.
5. **Socketing a high-speed part like the VCA821 device is not recommended.** The additional lead length and pin-to-pin capacitance introduced by the socket can create an extremely troublesome parasitic network, which can make it almost impossible to achieve a smooth, stable frequency response. Best results are obtained by soldering the VCA821 device onto the board.

## 12.2 Layout Example

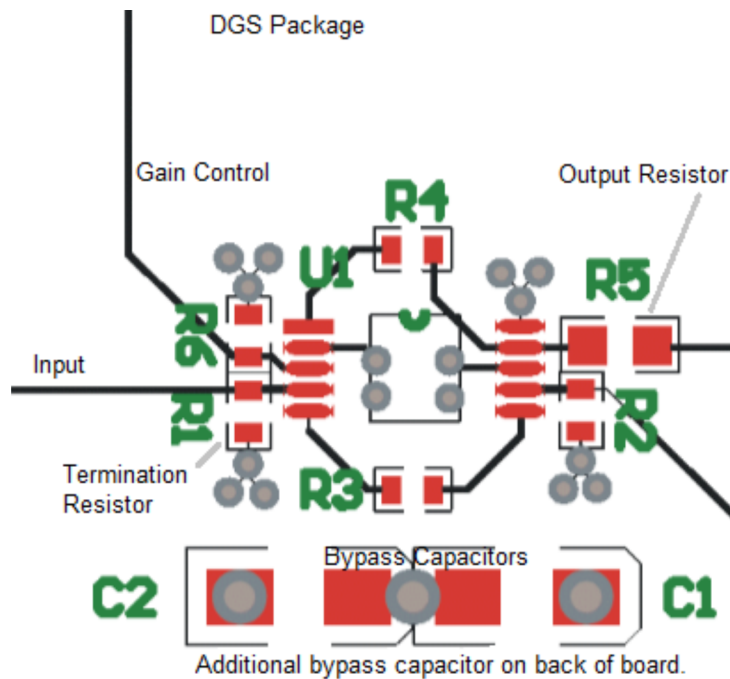


Figure 90. Layout Recommendations

## 12.3 Thermal Considerations

The VCA821 device does not require heat sinking or airflow in most applications. The maximum desired junction temperature sets the maximum allowed internal power dissipation as described in this section. The maximum junction temperature must not exceed 150°C.

Operating junction temperature ( $T_J$ ) is given by Equation 6.

$$T_J = T_A + P_D \times \theta_{JA} \quad (6)$$

The total internal power dissipation ( $P_D$ ) is the sum of quiescent power ( $P_{DQ}$ ) and additional power dissipated in the output stage ( $P_{DL}$ ) to deliver load power. Quiescent power is simply the specified no-load supply current times the total supply voltage across the part.  $P_{DL}$  depends on the required output signal and load; for a grounded resistive load; however, it is at a maximum when the output is fixed at a voltage equal to one-half of either supply voltage (for equal bipolar supplies). Under this worst-case condition,  $P_{DL} = V_S^2 / (4 \times R_L)$ , where  $R_L$  is the resistive load.

### NOTE

It is the power in the output stage and not in the load that determines internal power dissipation.

As a worst-case example, compute the maximum  $T_J$  using a VCA821ID (SOIC-14 package) in the circuit of Figure 79 operating at maximum gain and at the maximum specified ambient temperature of 85°C.

$$P_D = 10V(36mA) + 5^2 / (4 \times 100\Omega) = 422.5mW \quad (7)$$

$$\text{Maximum } T_J = +85^\circ\text{C} + (0.443W \times 80^\circ\text{C/W}) = 120.5^\circ\text{C} \quad (8)$$

This maximum operating junction temperature is well below most system level targets. Most applications must be lower because an absolute worst-case output stage power was assumed in this calculation of  $V_{CC} / 2$ , which is beyond the output voltage range for the VCA821 device.

## 13 Device and Documentation Support

### 13.1 Device Support

#### 13.1.1 Third-Party Products Disclaimer

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**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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### 13.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">VCA821ID</a>    | Active        | Production           | SOIC (D)   14    | 50   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | VCA821ID            |
| VCA821ID.A                  | Active        | Production           | SOIC (D)   14    | 50   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | VCA821ID            |
| <a href="#">VCA821IDGST</a> | Active        | Production           | VSSOP (DGS)   10 | 250   SMALL T&R       | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 85    | BOR                 |
| VCA821IDGST.A               | Active        | Production           | VSSOP (DGS)   10 | 250   SMALL T&R       | Yes         | NIPDAUAG                             | Level-2-260C-1 YEAR               | -40 to 85    | BOR                 |
| <a href="#">VCA821IDR</a>   | Active        | Production           | SOIC (D)   14    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | VCA821ID            |
| VCA821IDR.A                 | Active        | Production           | SOIC (D)   14    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | VCA821ID            |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

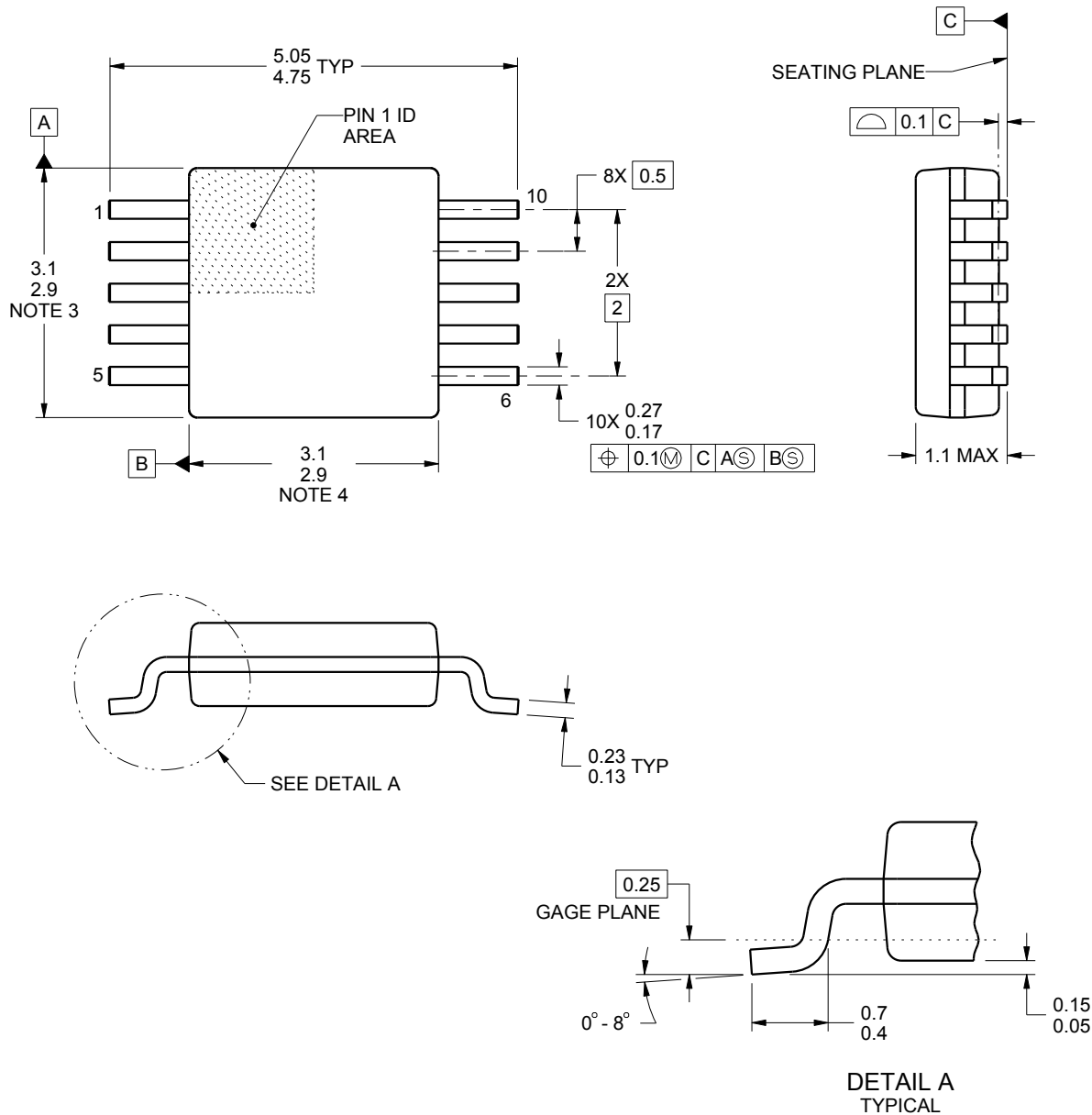
| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| VCA821IDGST | VSSOP        | DGS             | 10   | 250  | 180.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| VCA821IDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| VCA821IDGST | VSSOP        | DGS             | 10   | 250  | 213.0       | 191.0      | 35.0        |
| VCA821IDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |



4221984/A 05/2015

## NOTES:

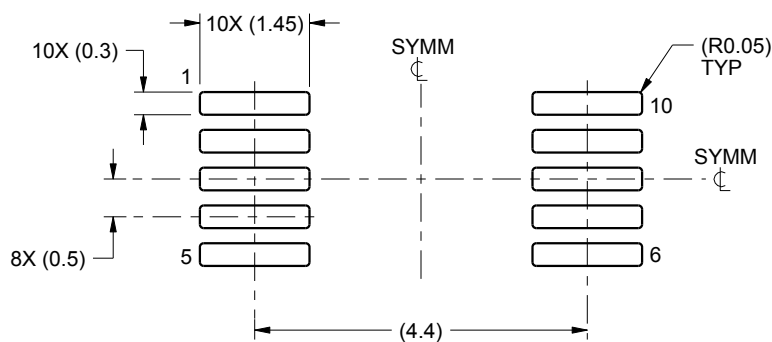
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-187, variation BA.

# EXAMPLE BOARD LAYOUT

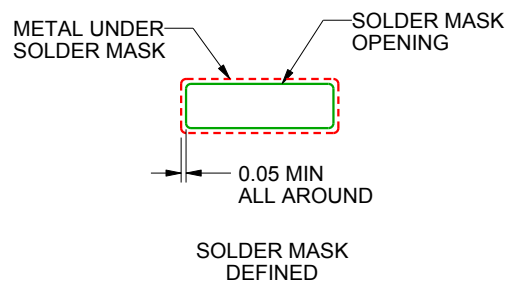
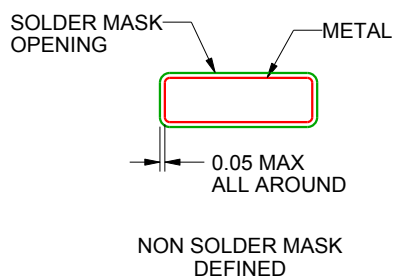
DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:10X



SOLDER MASK DETAILS  
NOT TO SCALE

4221984/A 05/2015

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

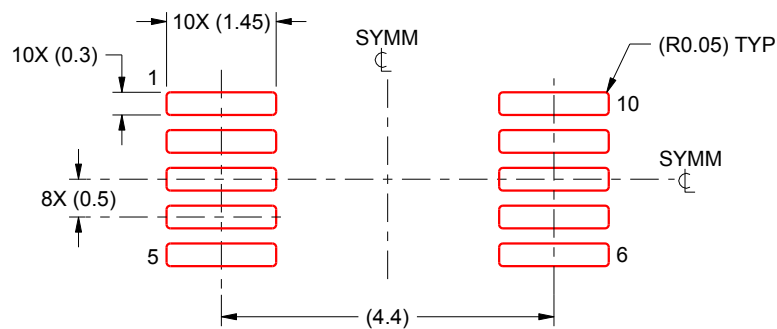
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DGS0010A

VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:10X

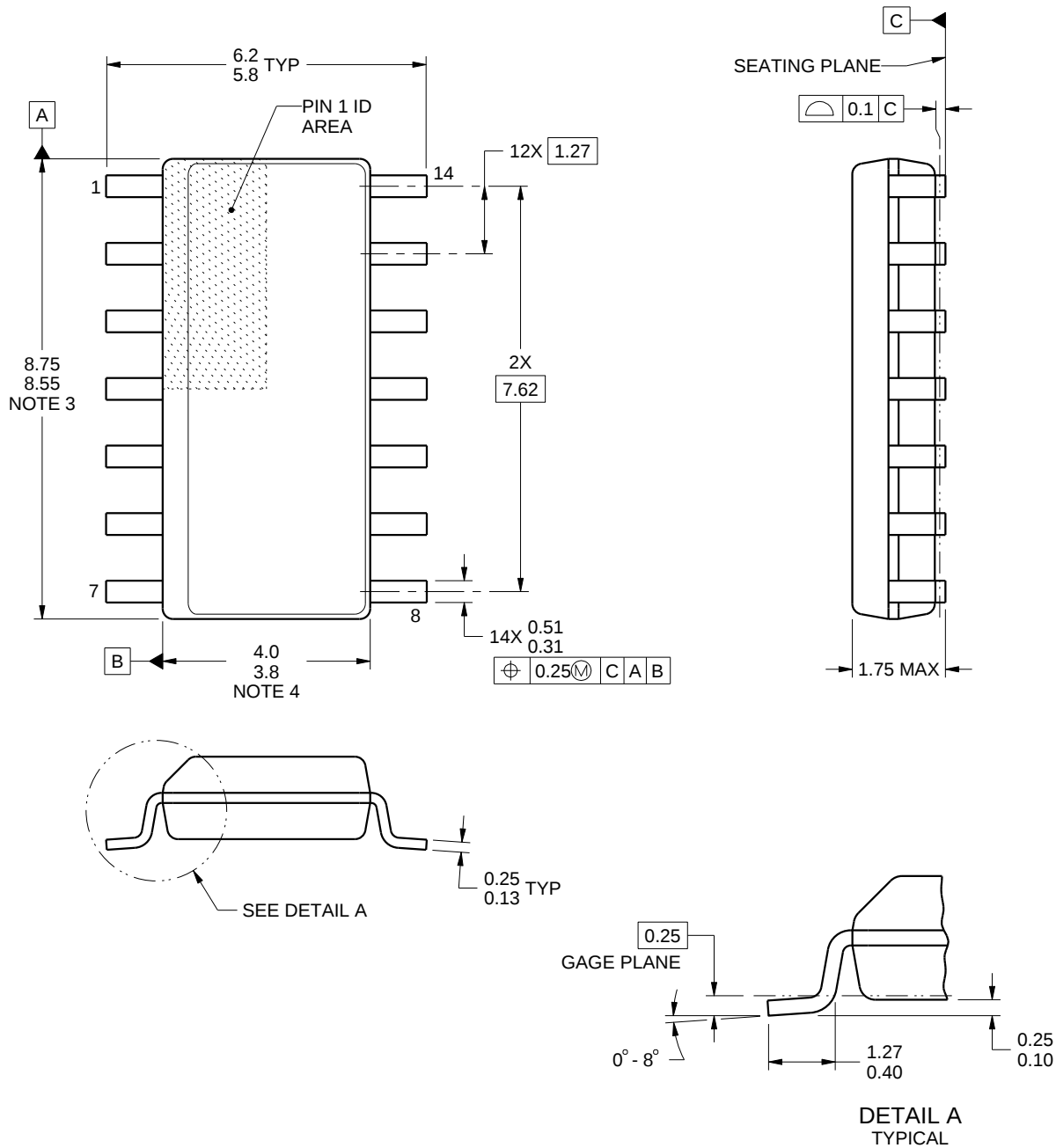
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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

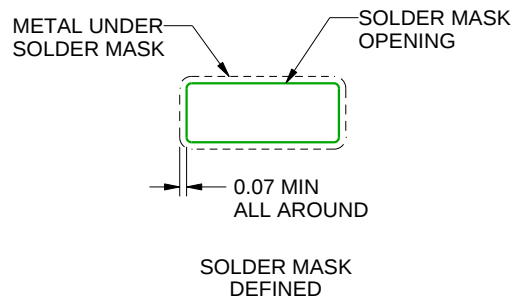
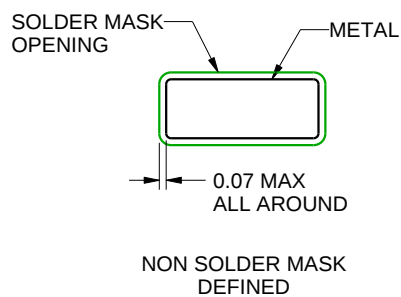
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

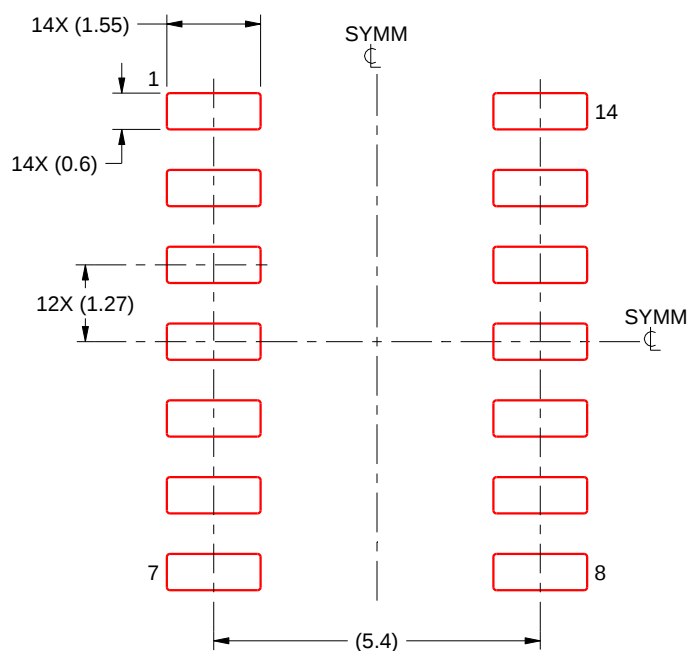
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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